



Introduction to Beam Instrumentation



Darmstadt, Germany

28th September – 9th October 2009

Rhodri Jones

(CERN Beam Instrumentation Group)

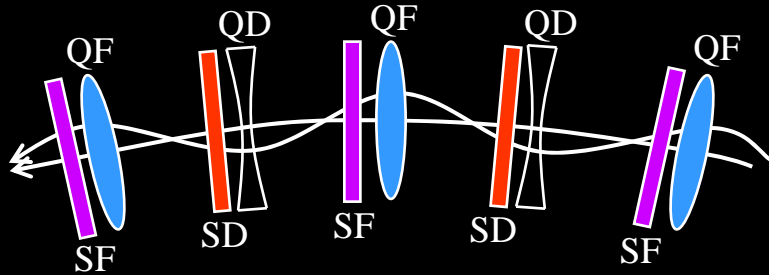


Introduction

- What do we mean by beam instrumentation?
 - The “eyes” of the machine operators
 - i.e. the instruments that observe beam behaviour
 - An accelerator can never be better than the instruments measuring its performance!
- What does work in beam instrumentation entail?
 - Design, construction & operation of instruments to observe particle beams
 - R&D to find new or improve existing techniques to fulfill new requirements
 - A combination of the following disciplines
 - Applied & Accelerator Physics; Mechanical, Electronic & Software Engineering
 - A fascinating field of work!
- What beam parameters do we measure?
 - Beam Position
 - Horizontal and vertical throughout the accelerator
 - Beam Intensity (& lifetime measurement for a storage ring/collider)
 - Bunch-by-bunch charge and total circulating current
 - Beam Loss
 - Especially important for superconducting machines
 - Beam profiles
 - Transverse and longitudinal distribution
 - Collision rate / Luminosity (for colliders)
 - Measure of how well the beams are overlapped at the collision point

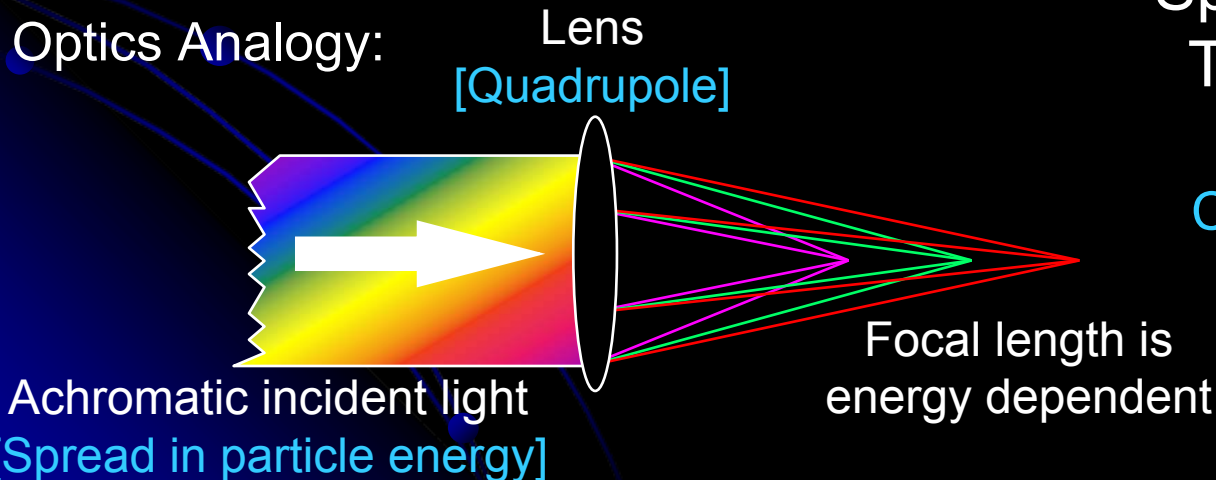
More Measurements

- Machine Tune



Characteristic Frequency
of the Magnet Lattice
Given by the strength of the
Quadrupole magnets

- Machine Chromaticity



Spread in the Machine
Tune due to Particle
Energy Spread
Controlled by Sextupole
magnets

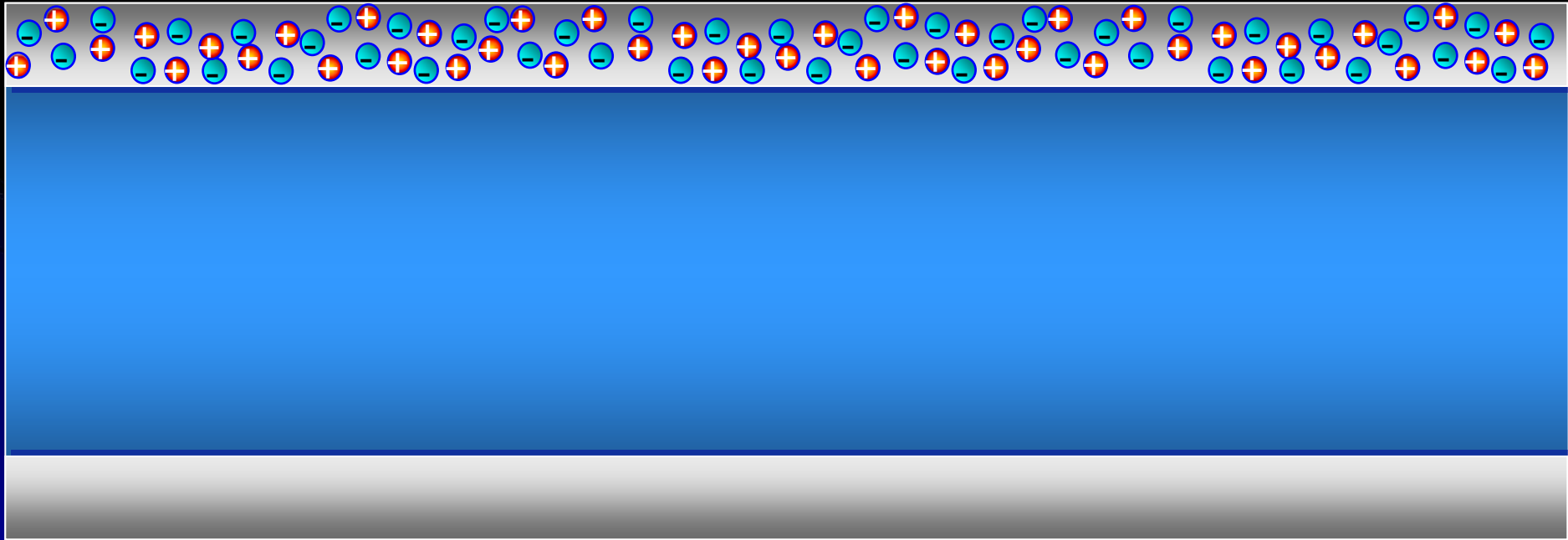


The Typical Instruments

- Beam Position
 - electrostatic or electromagnetic pick-ups and related electronics
- Beam Intensity
 - beam current transformers
- Beam Profile
 - secondary emission grids and screens
 - wire scanners
 - synchrotron light monitors
 - ionisation and luminescence monitors
 - femtosecond diagnostics for ultra short bunches (afternoon course)
- Beam Loss
 - ionisation chambers or pin diodes
- Machine Tune and Chromaticity
 - in diagnostics section of tomorrow
- Luminosity
 - in diagnostics section of tomorrow

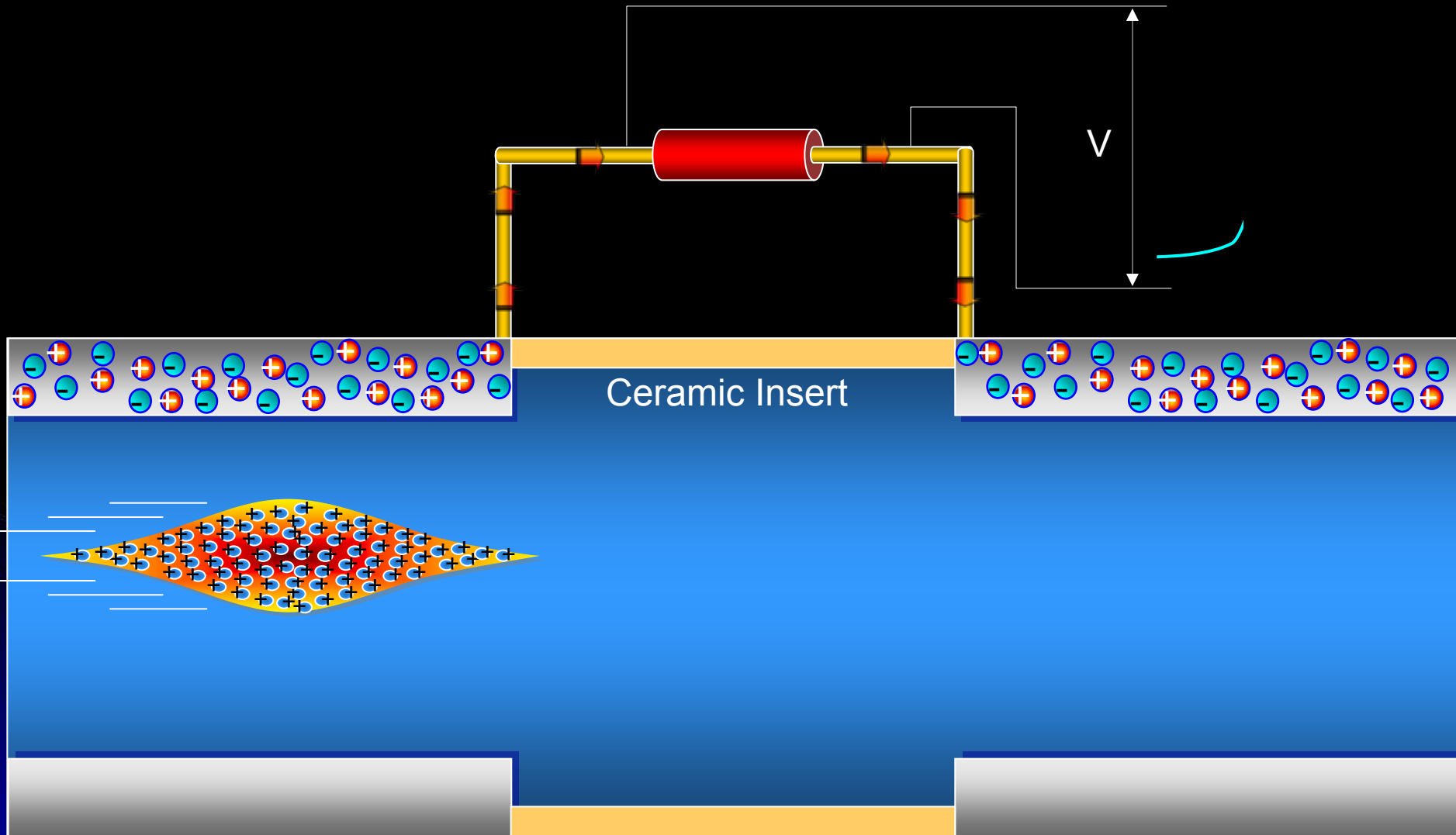


Measuring Beam Position – The Principle



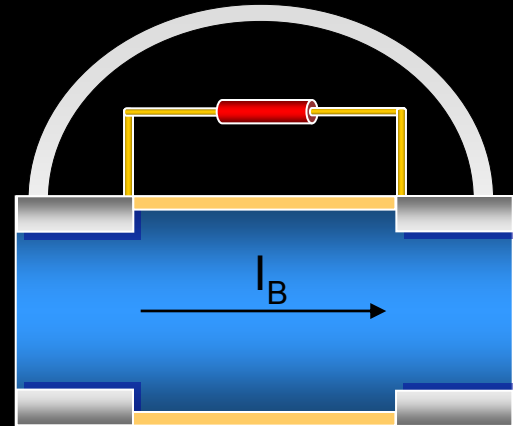
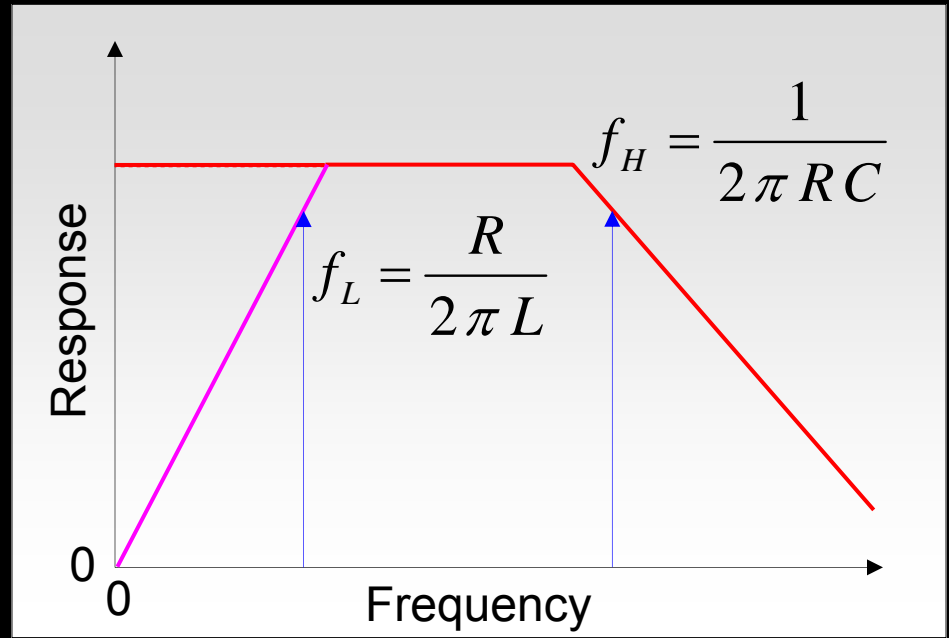
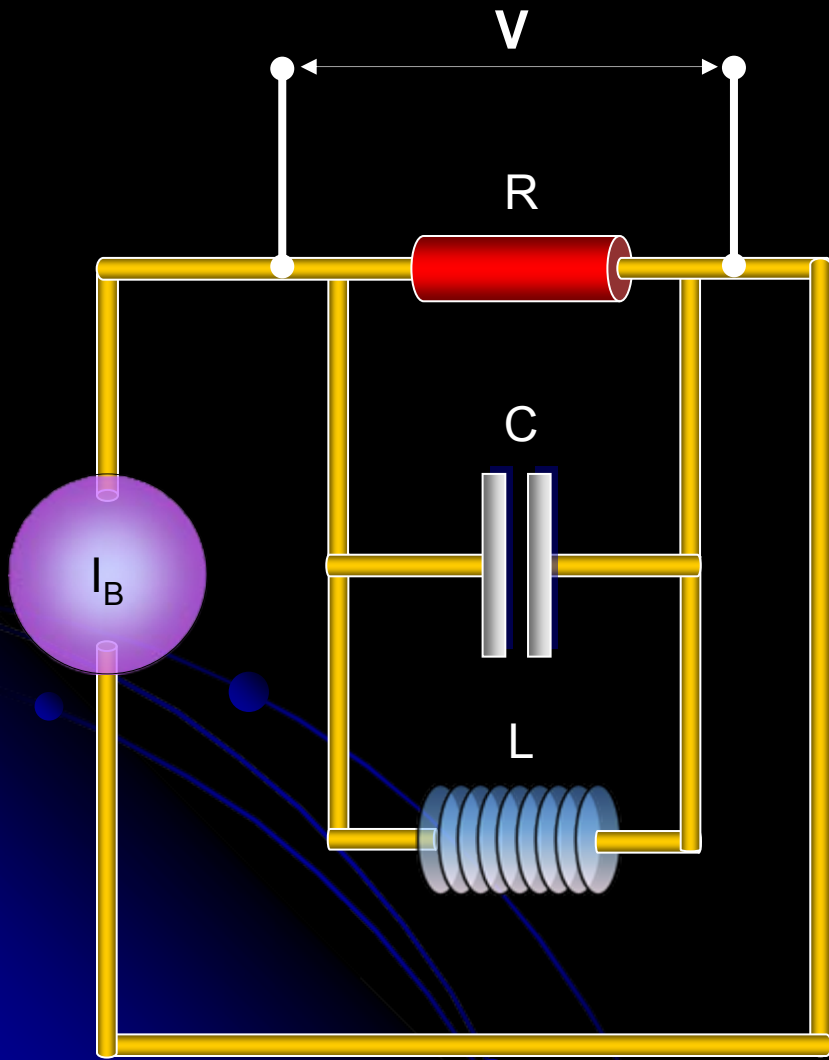


Wall Current Monitor – The Principle



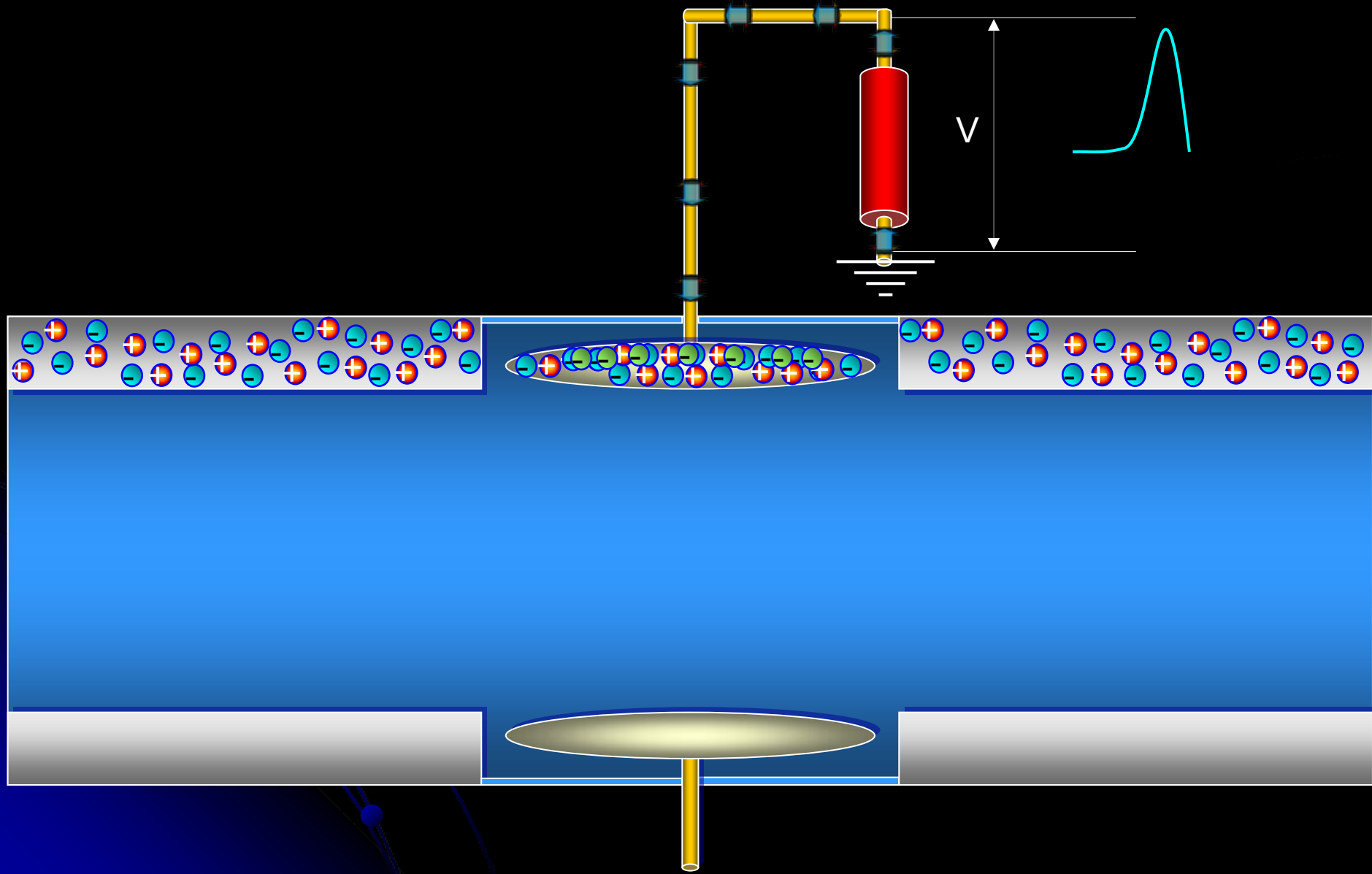


Wall Current Monitor – Beam Response

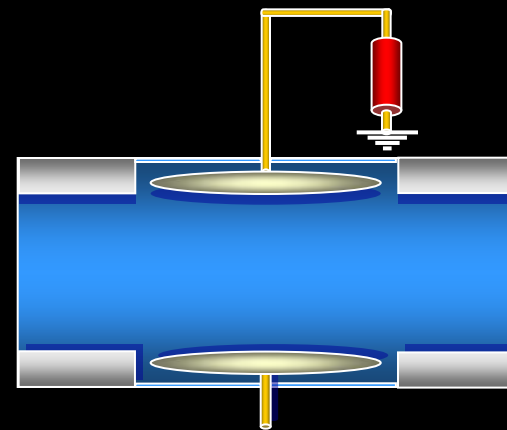
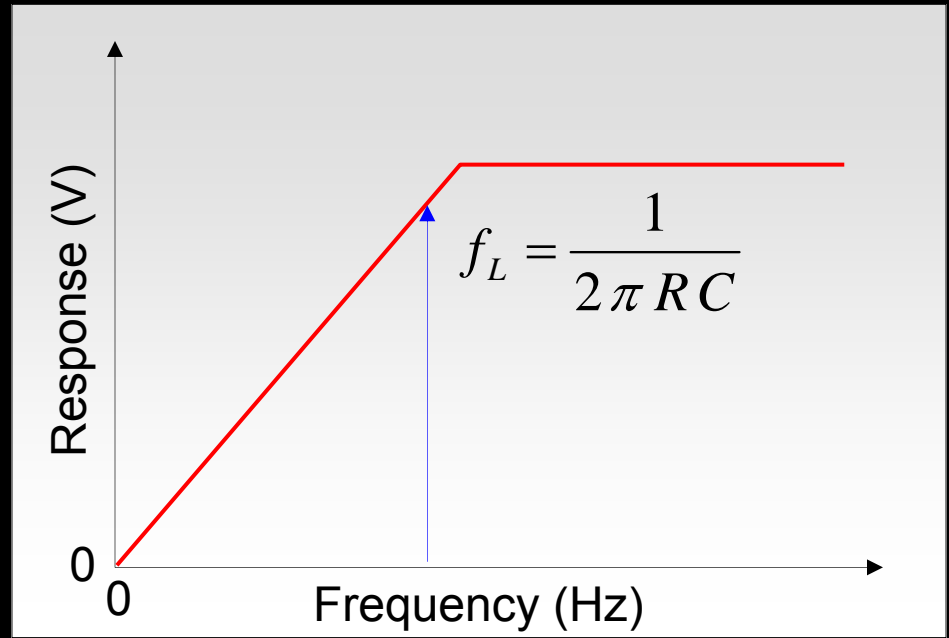
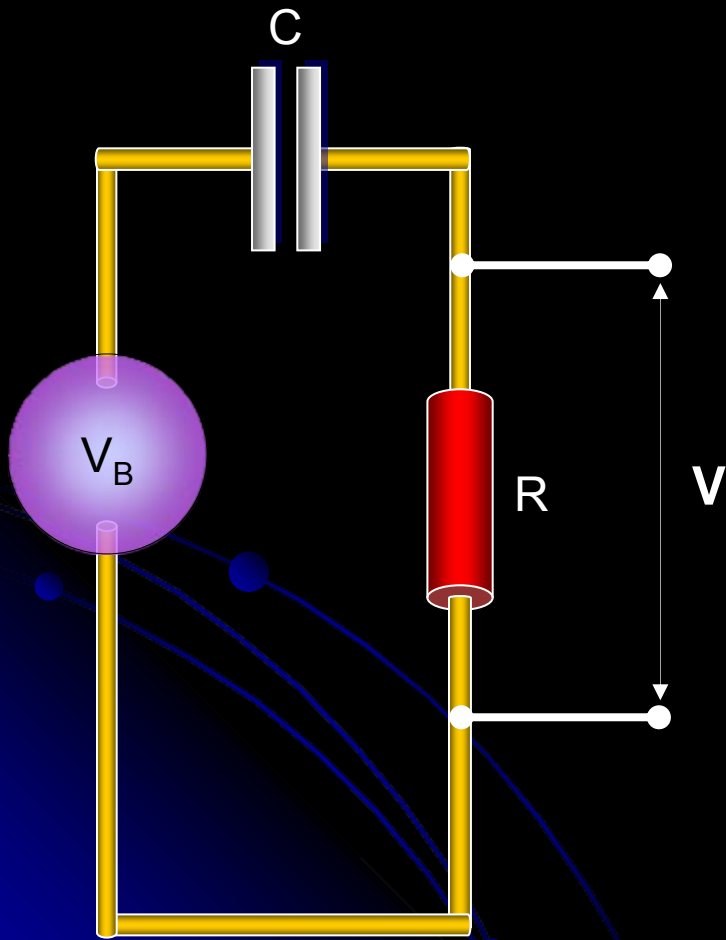




Electrostatic Monitor – The Principle



Electrostatic Monitor – Beam Response



Electrostatic Pick-up – Button

- ✓ Low cost \Rightarrow most popular
- ✗ Non-linear
 - requires correction algorithm when beam is off-centre

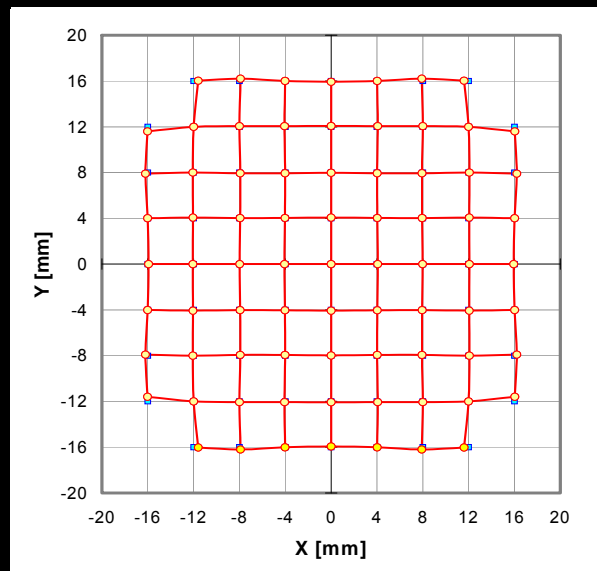
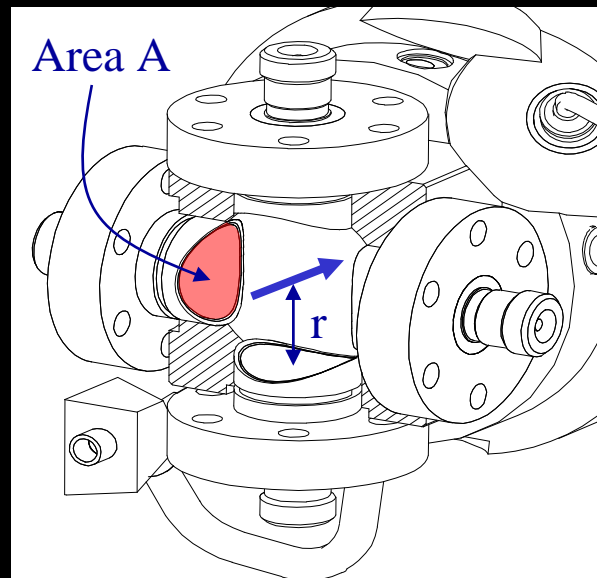
For Button with Capacitance C_e & Characteristic Impedance R_0

Transfer Impedance:

$$Z_{T(f \gg f_c)} = \frac{A}{(2\pi r) \times c \times C_e}$$

Lower Corner Frequency:

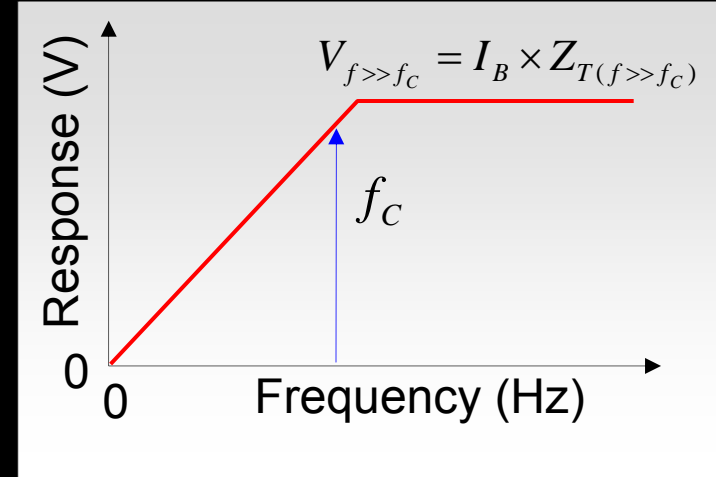
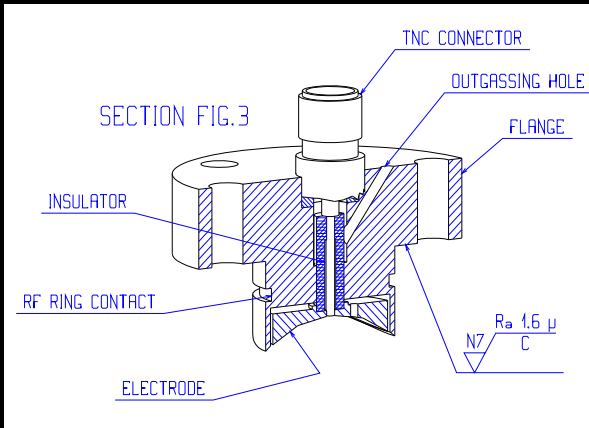
$$f_L = \frac{1}{2\pi R_0 C_e}$$



$$X = 2.30 \cdot 10^{-5} X_1^5 + 3.70 \cdot 10^{-5} X_1^3 + 1.035 X_1 + 7.53 \cdot 10^{-6} X_1^3 Y_1^2 + 1.53 \cdot 10^{-5} X_1 Y_1^4$$



A Real Example – The LHC Button



$$f_L = \frac{1}{2\pi RC} = \frac{1}{2\pi \times 50\Omega \times 8\text{pF}} = 400\text{MHz}$$

$$Z_{T\infty} = \frac{A}{(2\pi r) \times c \times C_e} = \frac{\pi \times (12\text{mm})^2}{(2\pi \times 24.5\text{mm}) \times c \times (8\text{pF})} = 1.2\Omega$$

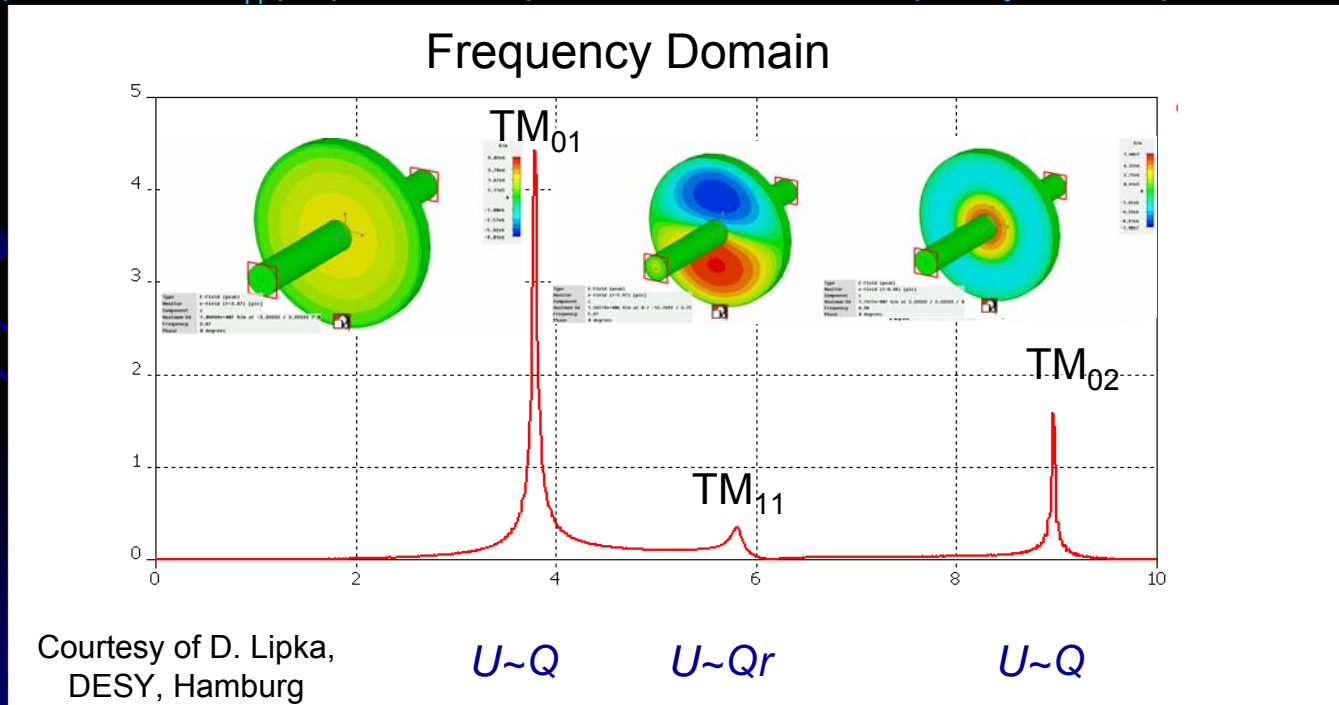
$$I_B = \frac{N_{pilot} e}{t} = \frac{5 \times 10^9 \times 1.6 \times 10^{-19}}{1 \times 10^{-9}} = 0.8 A_{peak} \Rightarrow V_{f=\infty} = 0.8 \times 1.2 = 1 V_{peak}$$

$$= \frac{N_{nom} e}{t} = \frac{1 \times 10^{11} \times 1.6 \times 10^{-19}}{1 \times 10^{-9}} = 16 A_{peak} \Rightarrow V_{f=\infty} = 16 \times 1.2 = 20 V_{peak}$$



Improving the Precision for Next Generation Accelerators

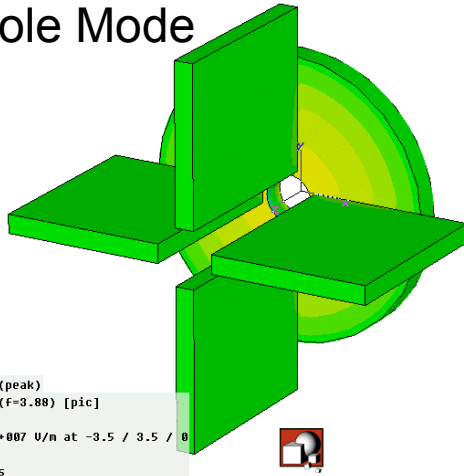
- Standard BPMs give intensity signals which need to be subtracted to obtain a difference which is then proportional to position
 - Difficult to do electronically without some of the intensity information leaking through
 - When looking for small differences this leakage can dominate the measurement
 - Typically 40-80dB (100 to 10000 in V) rejection \Rightarrow tens micron resolution for typical apertures
- Solution – cavity BPMs allowing sub micron resolution
 - Design the detector to collect only the difference signal
 - Dipole Mode TM_{11} proportional to position & shifted in frequency with respect to monopole mode



Today's State of the Art BPMs

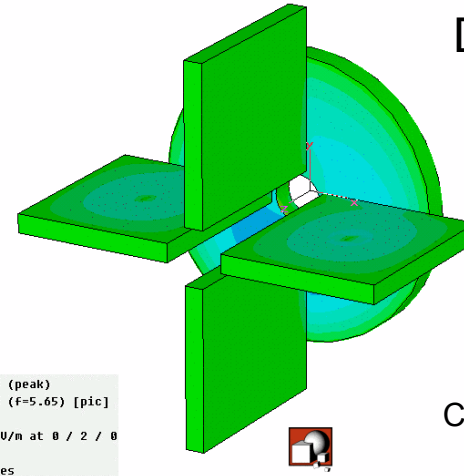
- Obtain signal using waveguides that only couple to dipole mode
 - Further suppression of monopole mode

Monopole Mode



Type	E-Field (peak)
Monitor	e-field (f=3.88) [pic]
Component	Normal
Maximum-3d	1.17338e+007 U/n at -3.5 / 3.5 / 0
Frequency	3.88
Phase	0 degrees

Dipole Mode

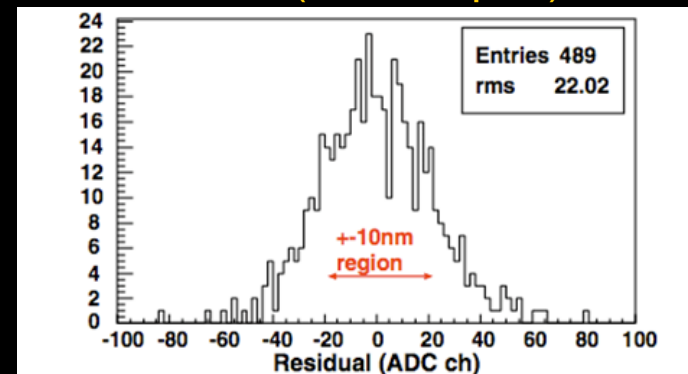
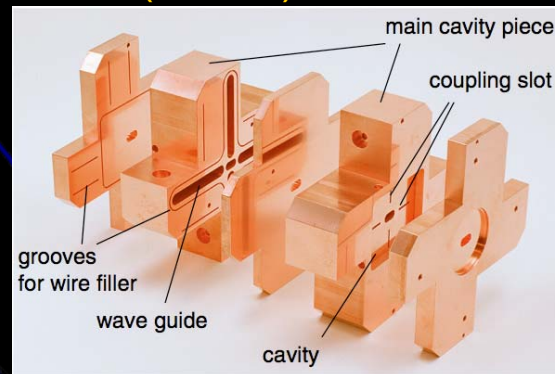
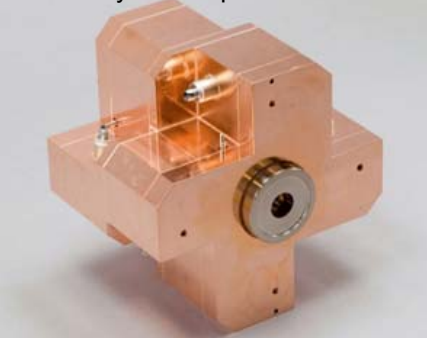


Type	E-Field (peak)
Monitor	e-field (f=5.65) [pic]
Component	Normal
Maximum-3d	639869 U/n at 0 / 2 / 0
Frequency	5.65
Phase	0 degrees

Courtesy of D. Lipka, DESY, Hamburg

- Prototype BPM for ILC Final Focus
 - Required resolution of 2nm (yes nano!) in a 6×12mm diameter beam pipe
 - Achieved World Record (so far!) resolution of 8.7nm at ATF2 (KEK, Japan)

Courtesy of D. Lipka & Y. Honda



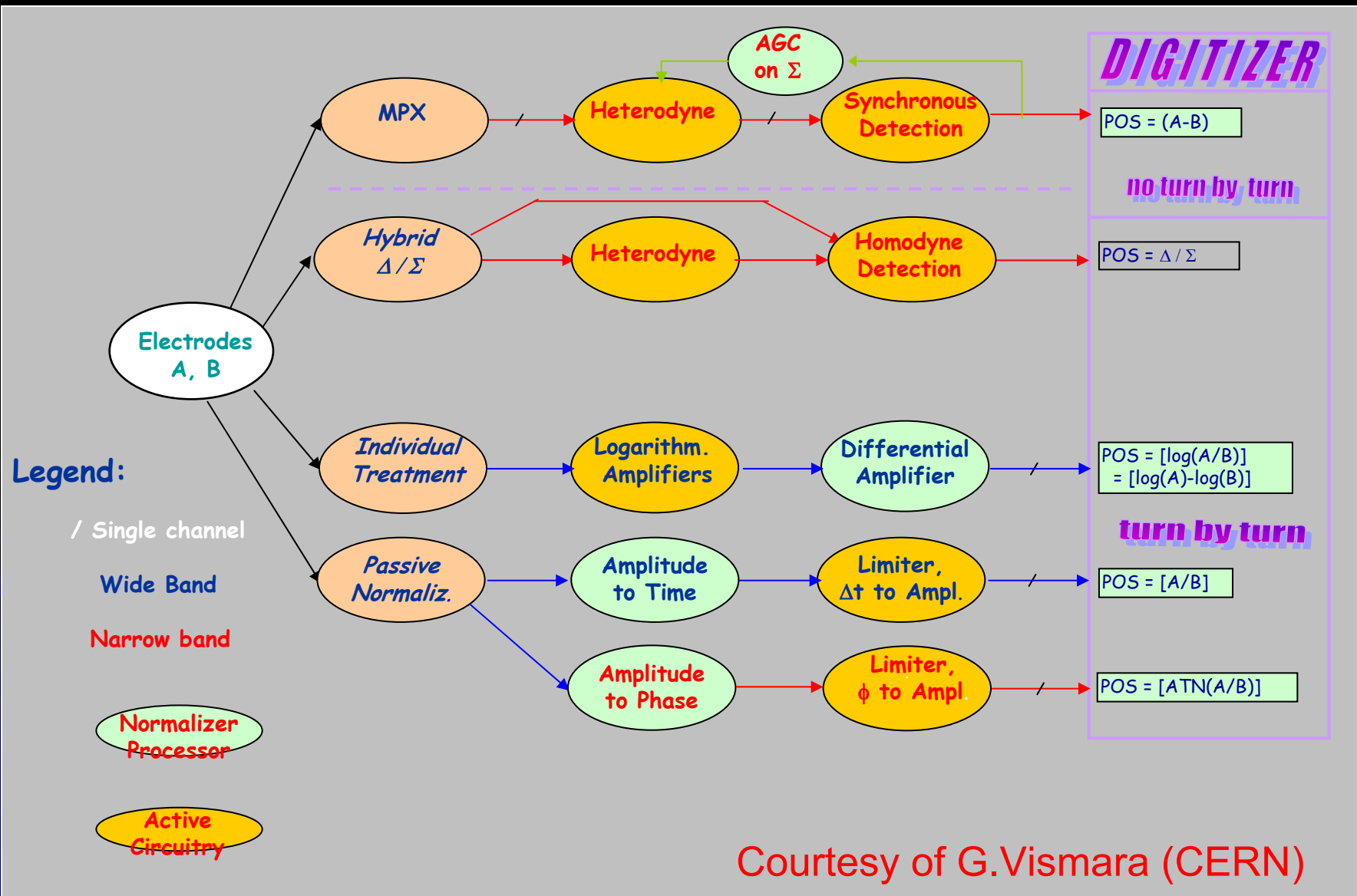


Criteria for Electronics Choice - so called “Processor Electronics”

- Accuracy
 - mechanical and electromagnetic errors
 - electronic components
- Resolution
- Stability over time
- Sensitivity and Dynamic Range
- Acquisition Time
 - measurement time
 - repetition time
- Linearity
 - aperture & intensity
- Radiation tolerance

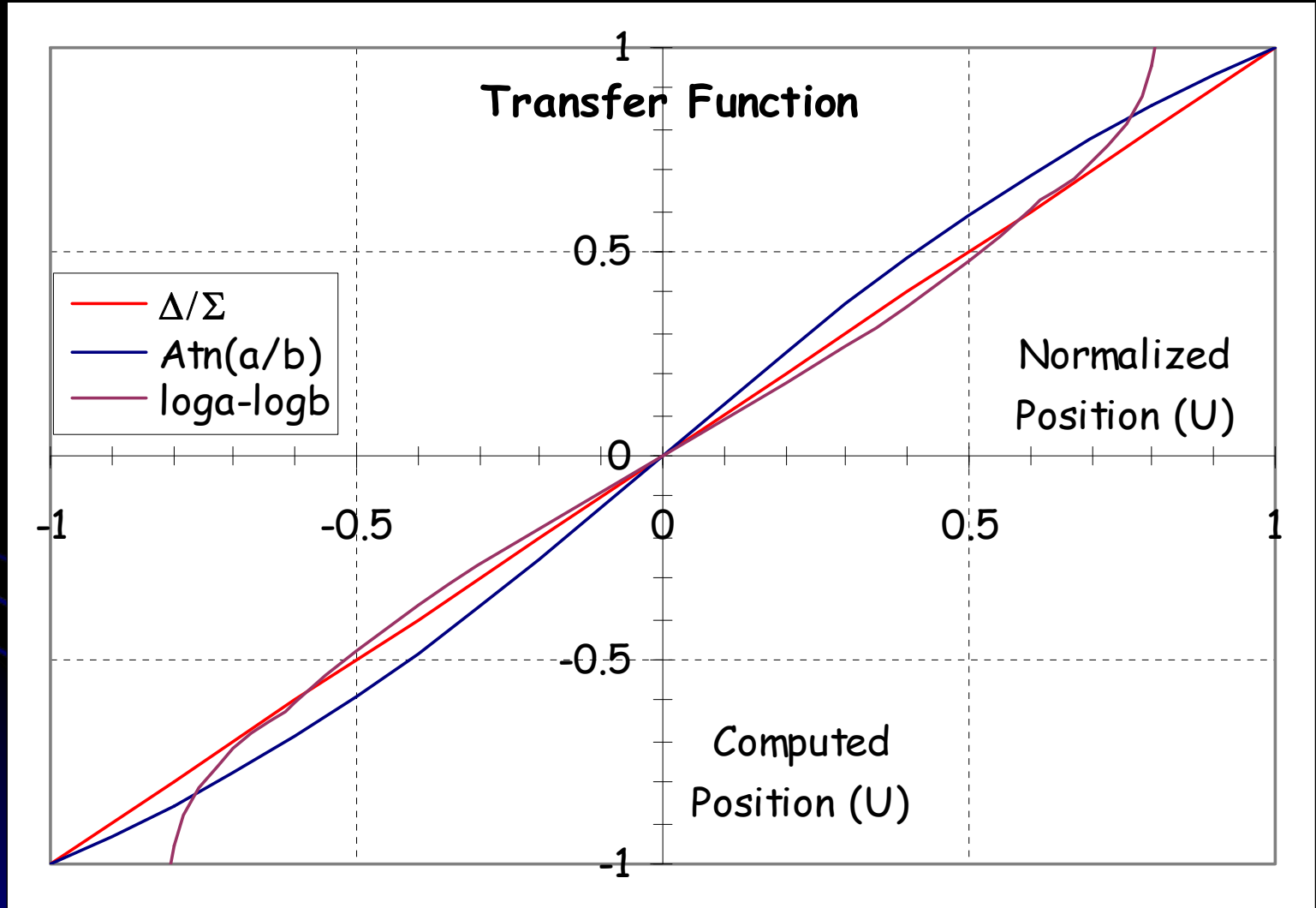


Processing System Families



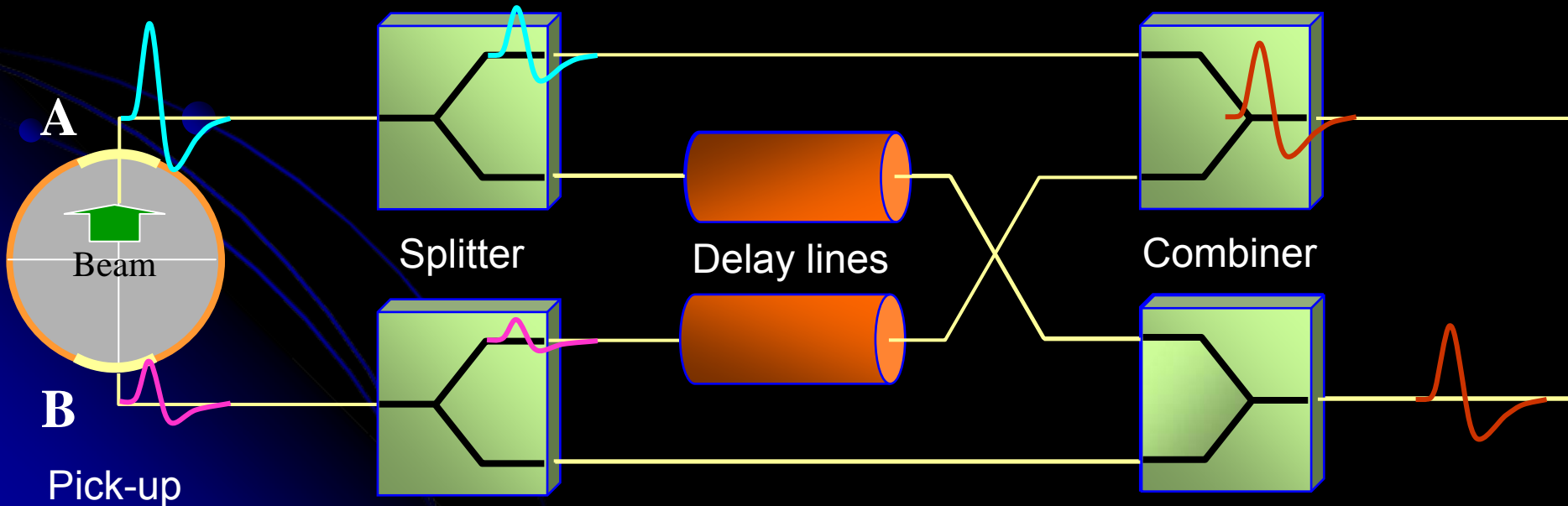
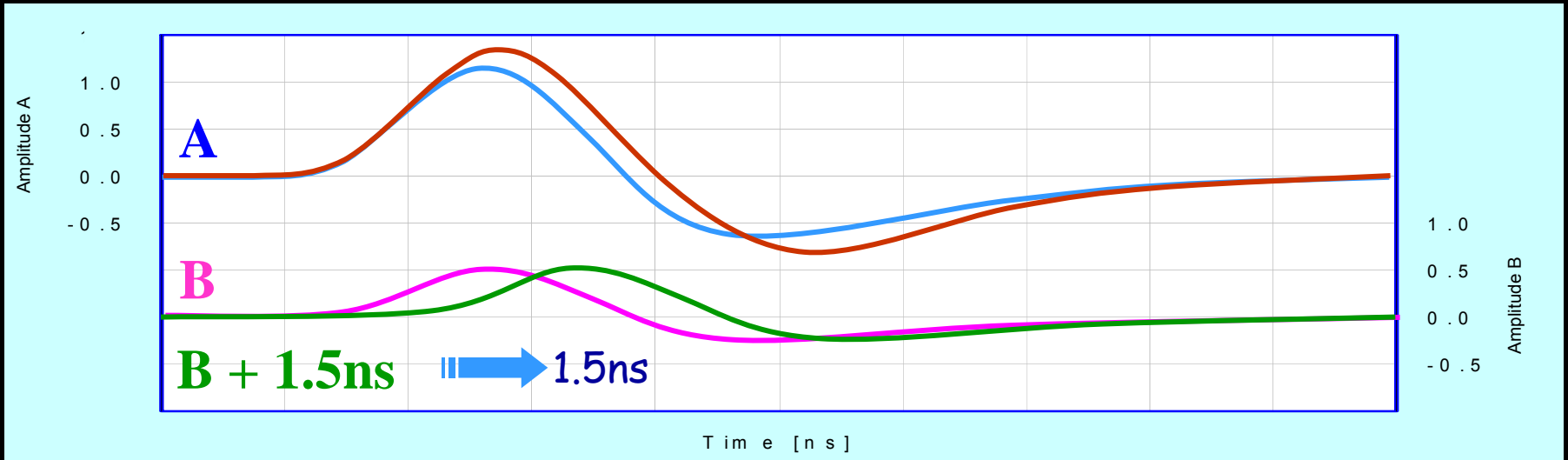


LINEARITY Comparison



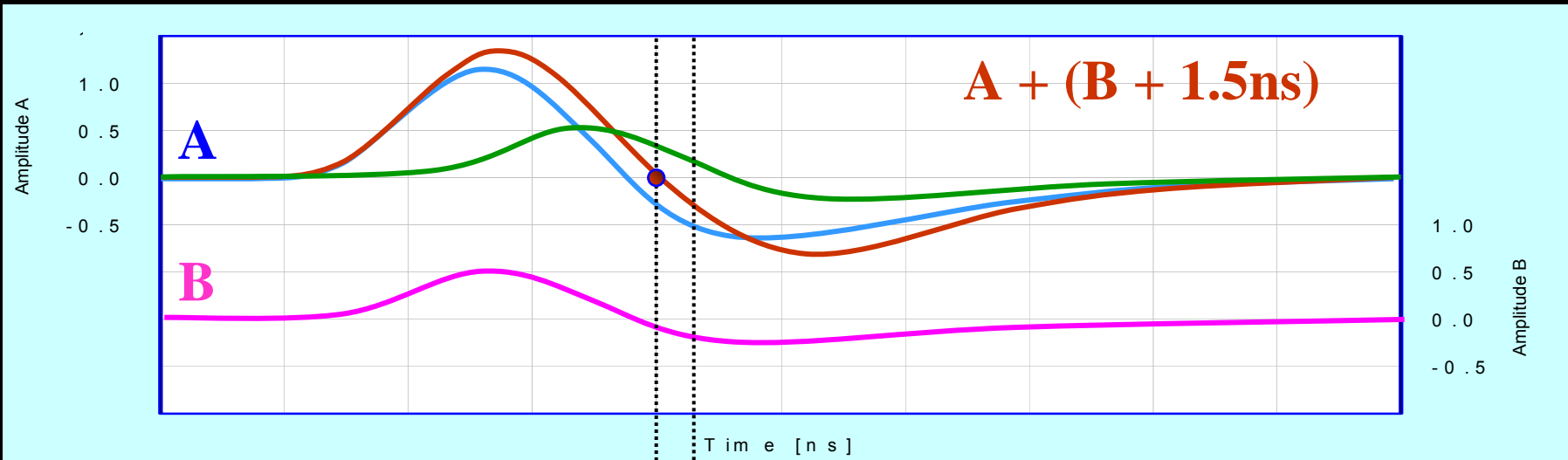


Amplitude to Time Normalisation

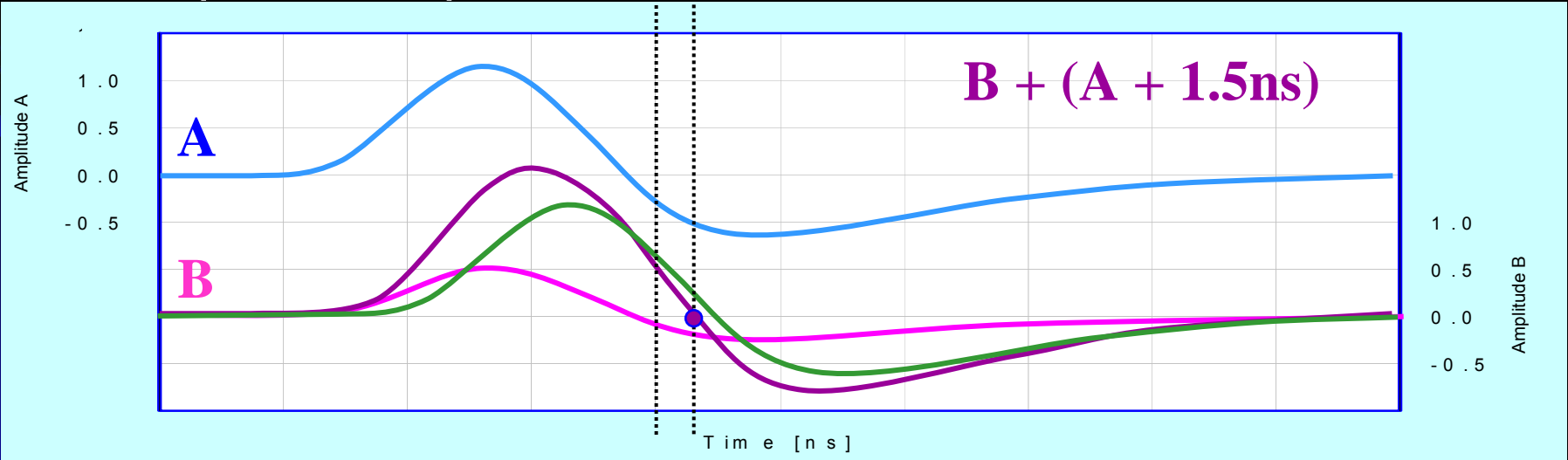




Amplitude to Time Normalisation



Δt depends on position \leftarrow





BPM Acquisition Electronics

Amplitude to Time Normaliser

Advantages

- Fast normalisation ($< 25\text{ns}$)
 - **bunch to bunch measurement**
- Signal dynamic independent of the number of bunches
 - **Input dynamic range $\sim 45\text{ dB}$**
 - **No need for gain selection**
- Reduced number of channels
 - **normalisation at the front-end**
- $\sim 10\text{ dB}$ compression of the position dynamic due to the recombination of signals
- Independent of external timing
- Time encoding allows fibre optic transmission to be used

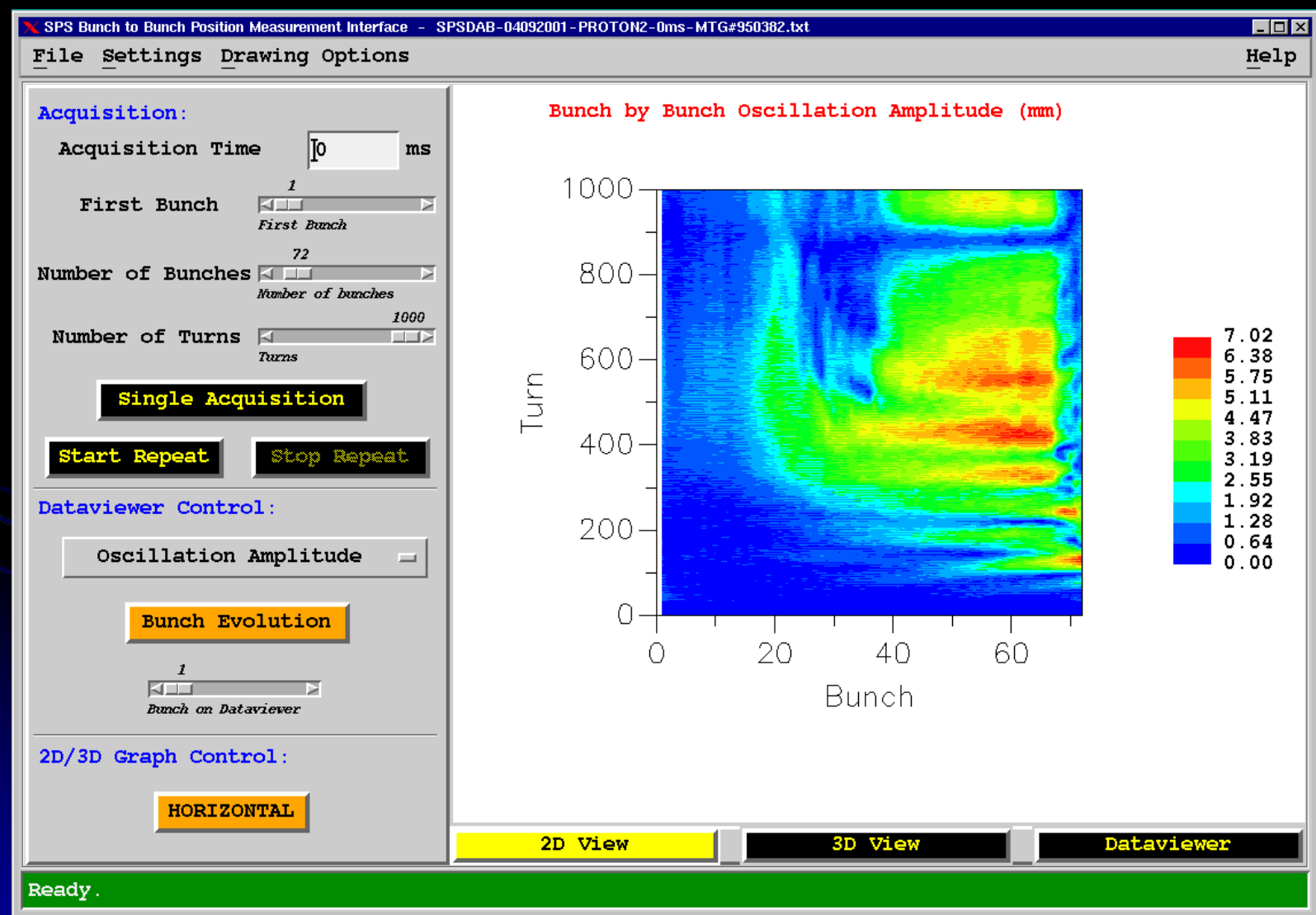
Limitations

- Currently reserved for beams with empty RF buckets between bunches e.g.
 - **LHC 400MHz RF but 25ns spacing**
 - **1 bunch every 10 buckets filled**
- Tight time adjustment required
- No Intensity information
- Propagation delay stability and switching time uncertainty are the limiting performance factors



What one can do with such a System

Used in the CERN-SPS for electron cloud & instability studies.

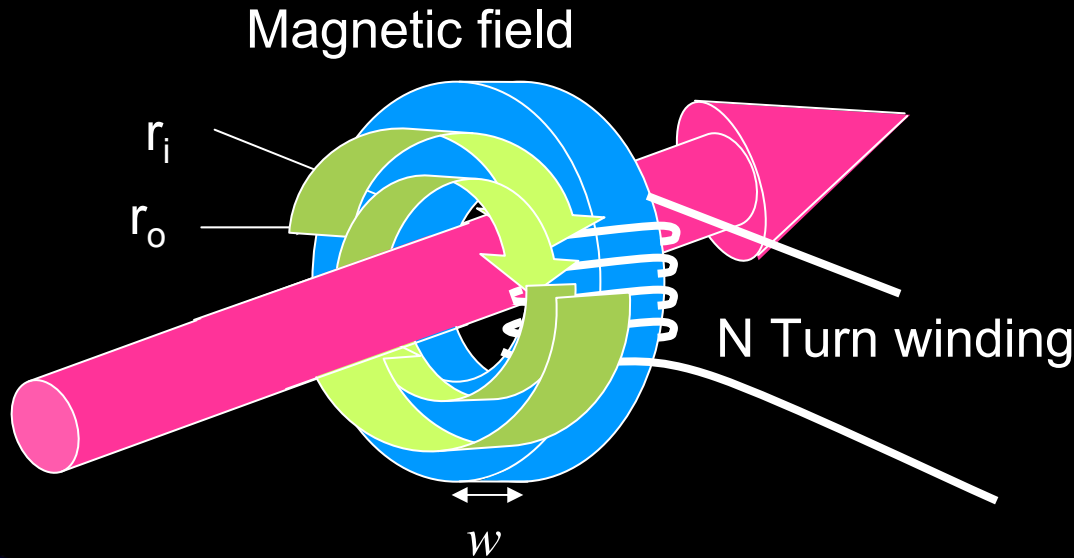




The Typical Instruments

- Beam Position
 - electrostatic or electromagnetic pick-ups and related electronics
- Beam Intensity
 - beam current transformers
- Beam Profile
 - secondary emission grids and screens
 - wire scanners
 - synchrotron light monitors
 - ionisation and luminescence monitors
 - Femtosecond diagnostics for ultra short bunches (afternoon course)
- Beam Loss
 - ionisation chambers or pin diodes
- Machine Tunes and Chromacities
 - in diagnostics section of tomorrow
- Luminosity
 - in diagnostics section of tomorrow

Current Transformers



Fields are very low

Capture magnetic field lines with cores of high relative permeability

(CoFe based amorphous alloy Vitrovac: $\mu_r = 10^5$)

Beam current

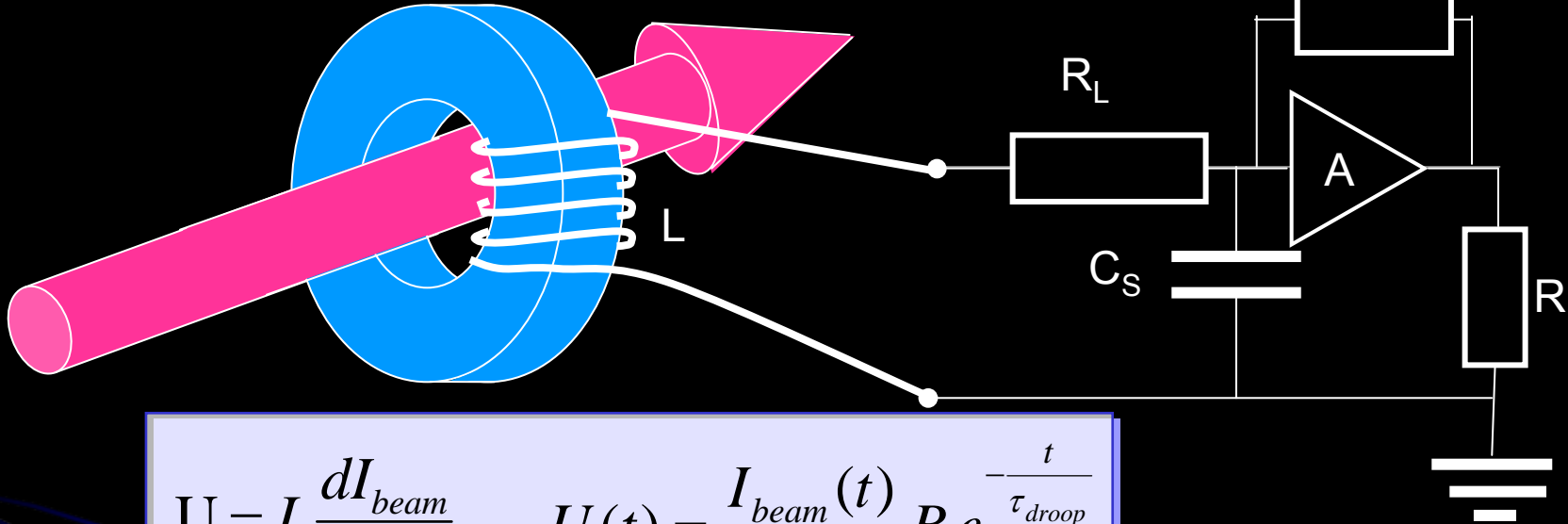
$$I_{Beam} = \frac{e N_q}{t} = \frac{e N_q \beta c}{w}$$

Transformer Inductance

$$L = \frac{\mu_0 \mu_r}{2\pi} w N^2 \ln \frac{r_o}{r_i}$$

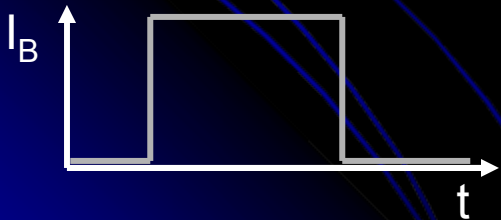
The Active AC transformer

Winding of N turns and Inductance L

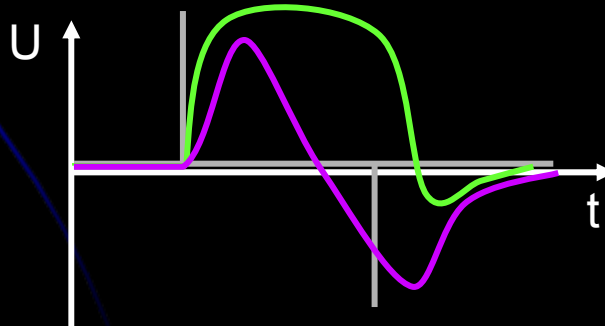


$$U = L \frac{dI_{beam}}{dt} \quad U(t) = \frac{I_{beam}(t)}{N} R e^{-\frac{t}{\tau_{droop}}}$$

Beam signal



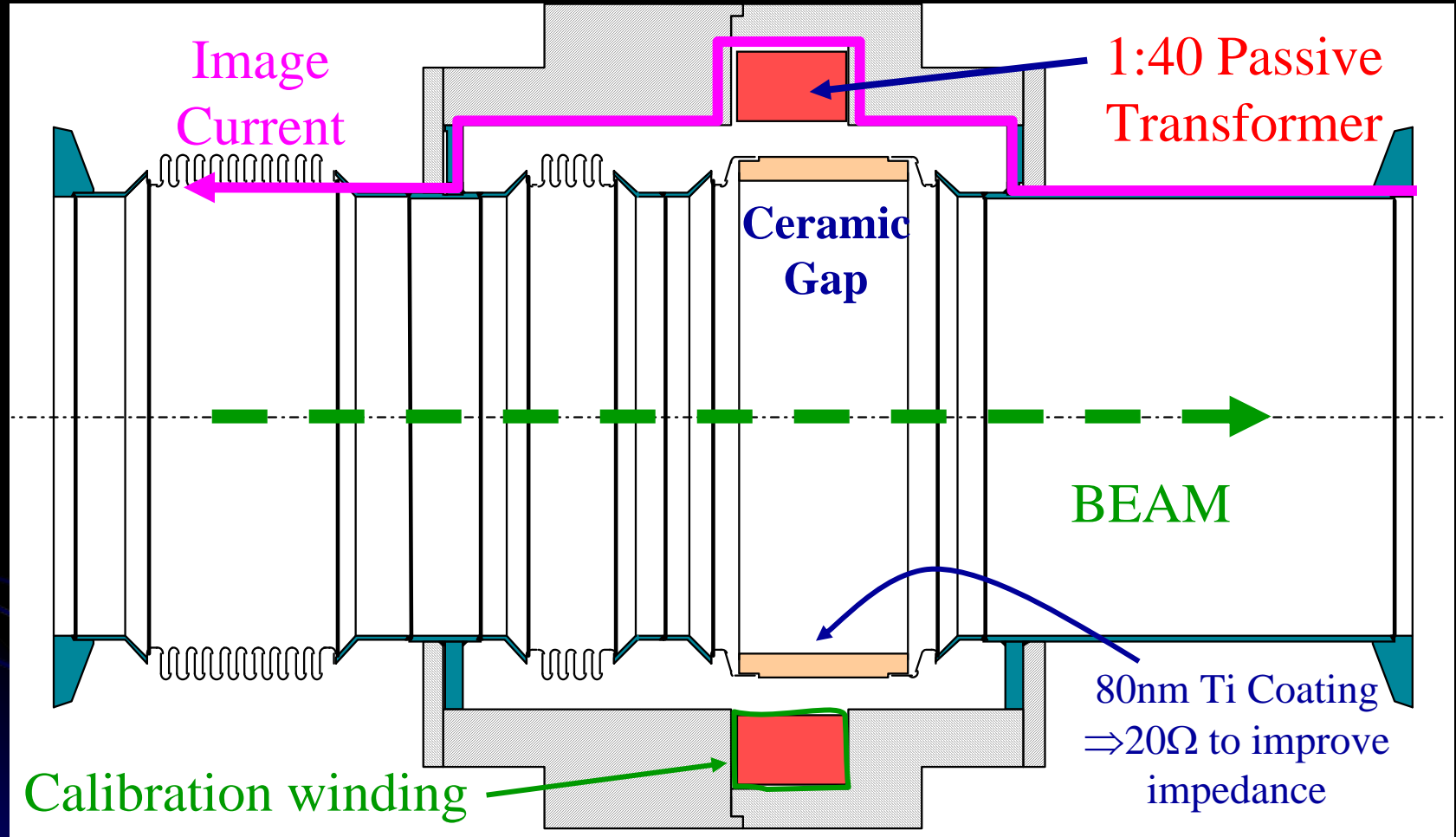
Transformer output signal



$$\tau_{rise} = \sqrt{L_s C_s}$$

$$\tau_{droop} = \frac{L}{\frac{R_f}{A} + R_L} \approx \frac{L}{R_L}$$

Fast Beam Current Transformer



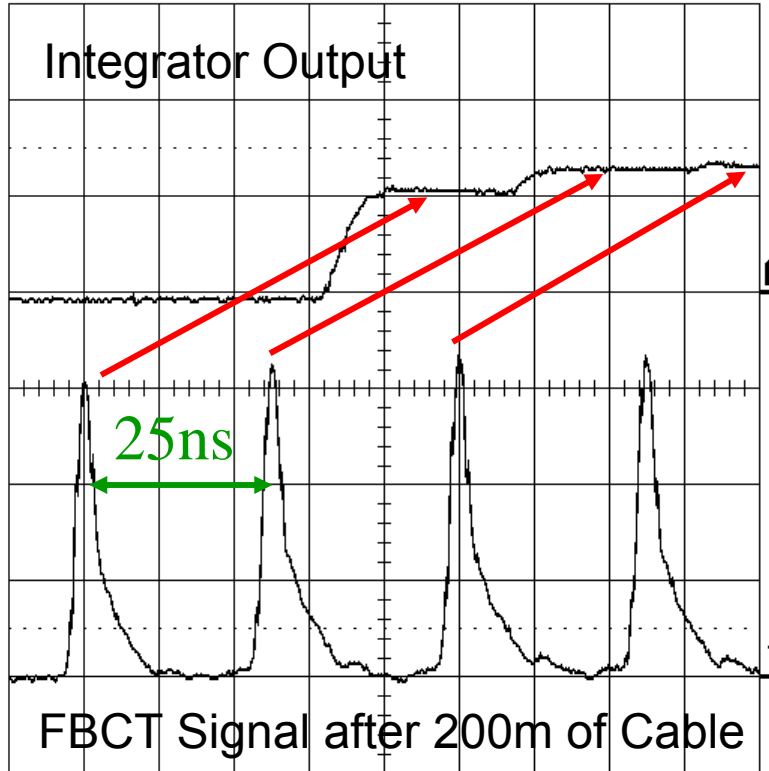
- 500MHz Bandwidth
- Low droop ($< 0.2\%/μs$)

Acquisition Electronics

20-Aug-02
16:32:12

1 10 ns
0.50 V

2 -4 10 ns
0.50 V



10 ns RIS

1 .5 V DC
2 2 V 50Ω
3 2 V 50Ω
4 .5 V 50Ω

2 DC 0.92 V



Data taken on LHC type beams at the CERN-SPS



What one can do with such a System

SPS Bunch to Bunch Position Measurement Interface - FSTBCT-06092002-PROTON2-0ms-MTG#1.txt

File Settings Drawing Options Help

Acquisition: **Multi Acquisition**

Acquisition Time: 0 ms

First Bunch: 1

Number of Bunches: 72

Number of Turns: 1

Start Acquisition

Start Repeat **Stop Repeat**

Dataviewer Control:

Batch Evolution

Trace 1 on Dataviewer: 2, 9 ms

Trace 2 on Dataviewer: 2, 9 ms

Turn on Dataviewer: 1

CERN/SL XDataviewer 6.4 ZOOMIN:Pick first point Kick Clean Reverse

Views Subview External Editor Select

Plot Grid OFF Zeroline OFF OP ONE Zoom In Box

Profiles 06/09/02 17:07:19

Bunch Intensity -3.6 Bunch 74.6

Tum 1

Da 48.0000 0.0056 dy -0.1297 Cu 47.8789 -0.1241 pl_trace1

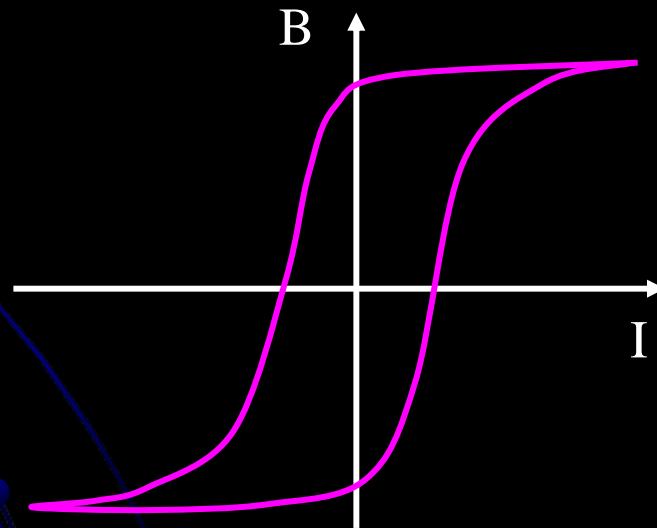
2D View **3D View** **Dataviewer**

Ready ...

Bad RF Capture of a single LHC Batch in the SPS (72 bunches)

The DC current transformer

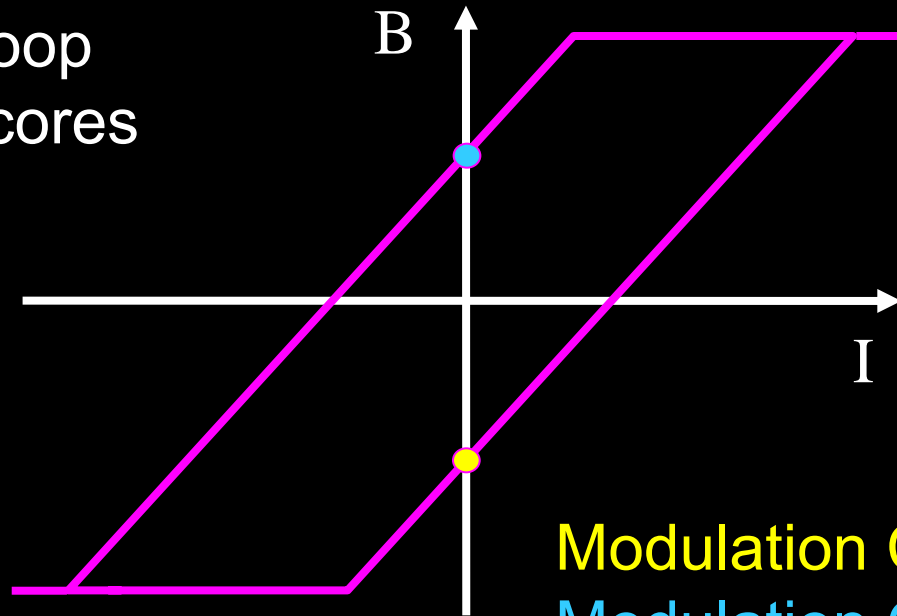
- AC current transformer can be extended to very low frequency but not to DC (no di/dt !)
- DC current measurement is required in storage rings
- To do this:
 - Take advantage of non-linear magnetisation curve
 - Apply a modulation frequency to 2 identical cores



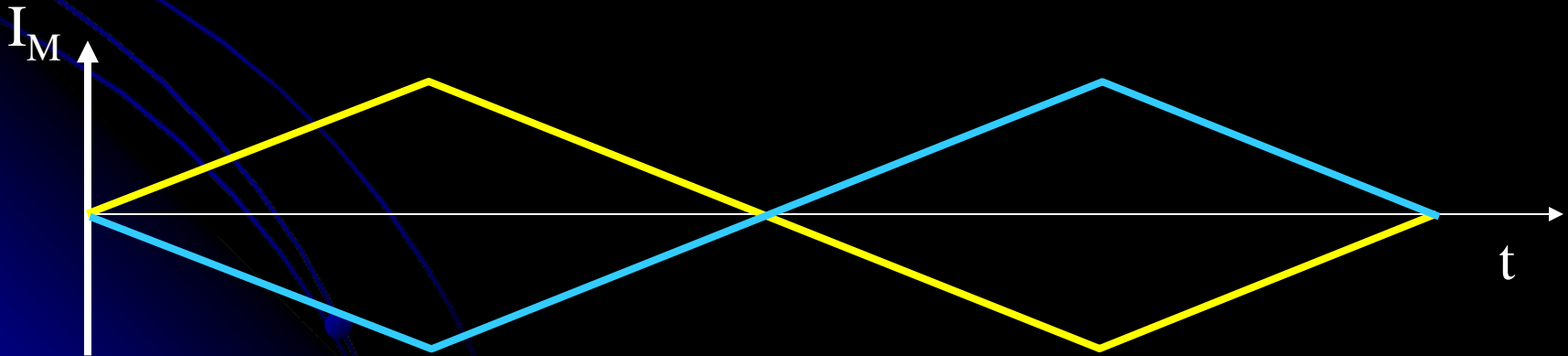


DCCT Principle – Case 1: no beam

Hysteresis loop of modulator cores



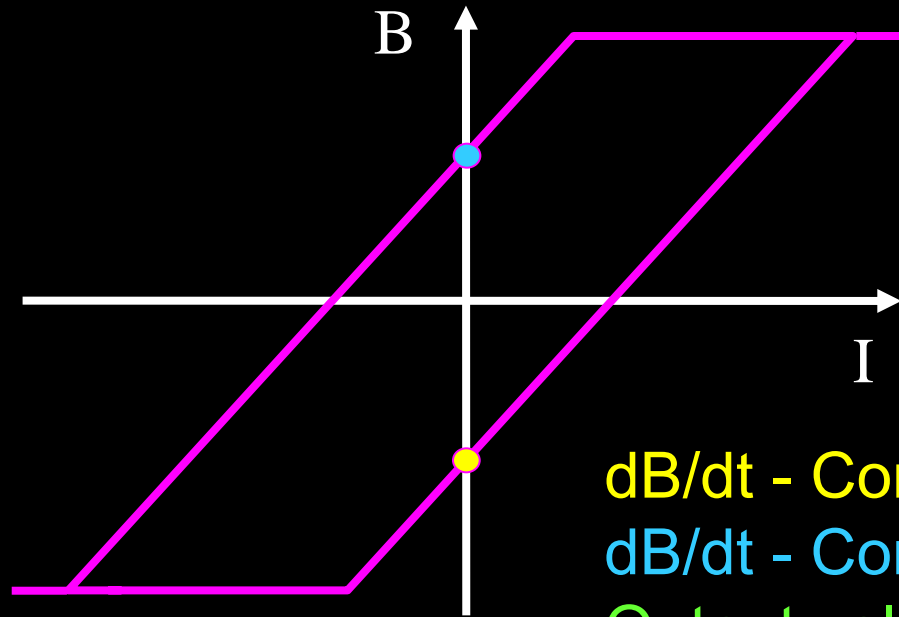
Modulation Current - Core 1
Modulation Current - Core 2



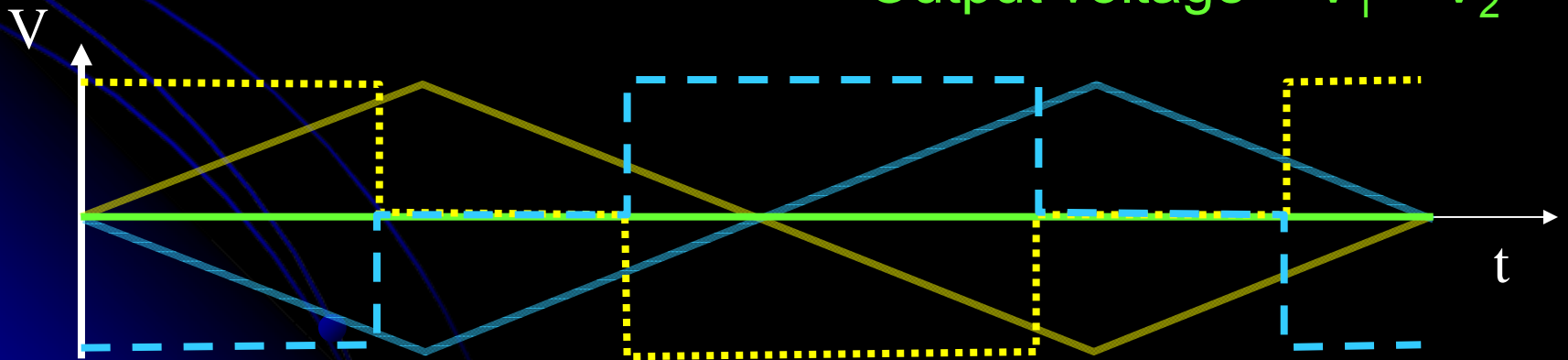


DCCT Principle – Case 1: no beam

$$V \propto \frac{dB}{dt}$$



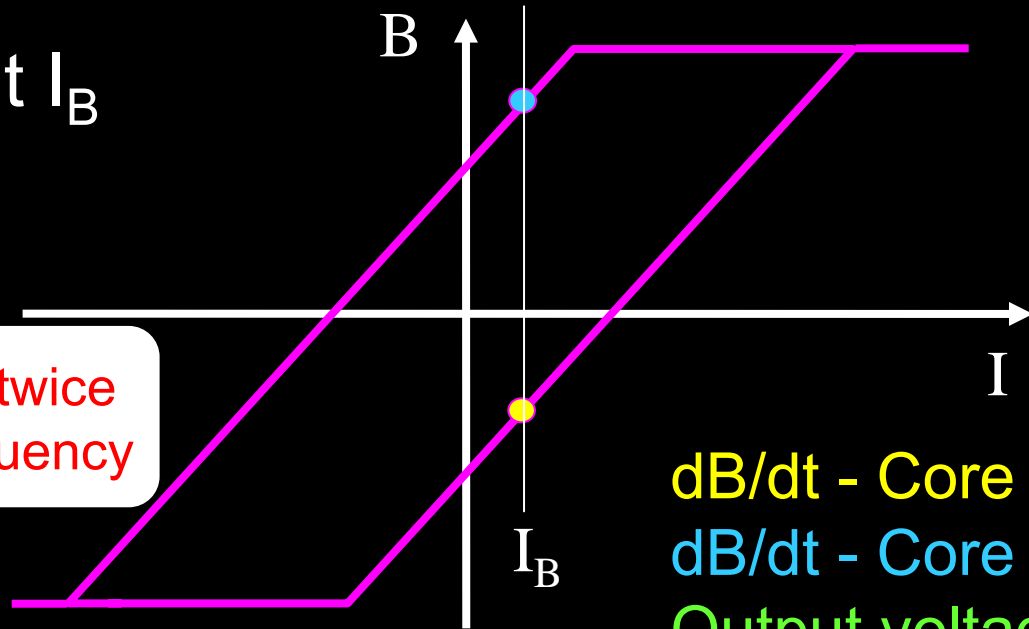
$\frac{dB}{dt}$ - Core 1 (V1)
 $\frac{dB}{dt}$ - Core 2 (V2)
Output voltage = $V_1 - V_2$



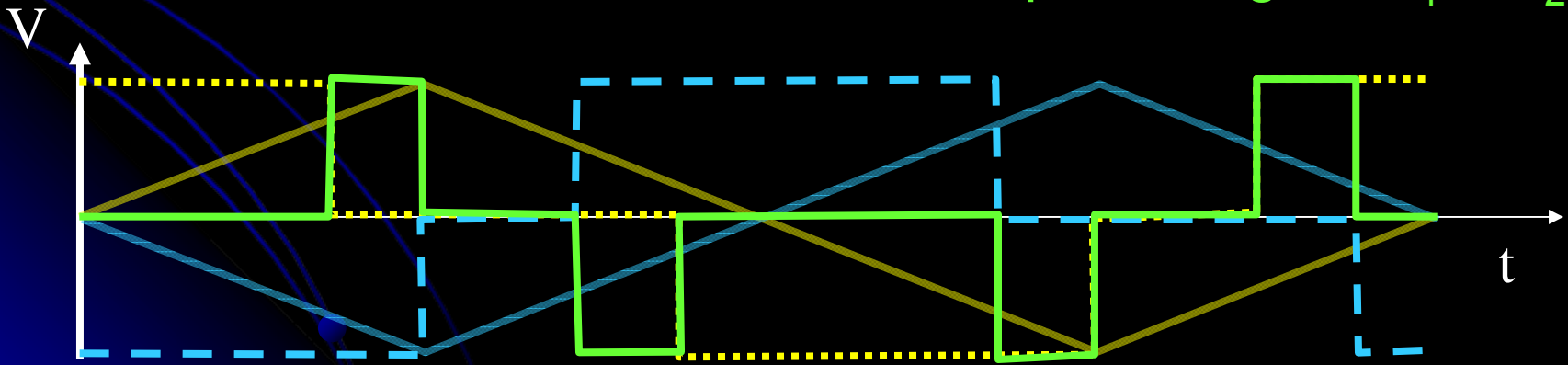


DCCT Principle – Case 2: with beam

Beam Current I_B

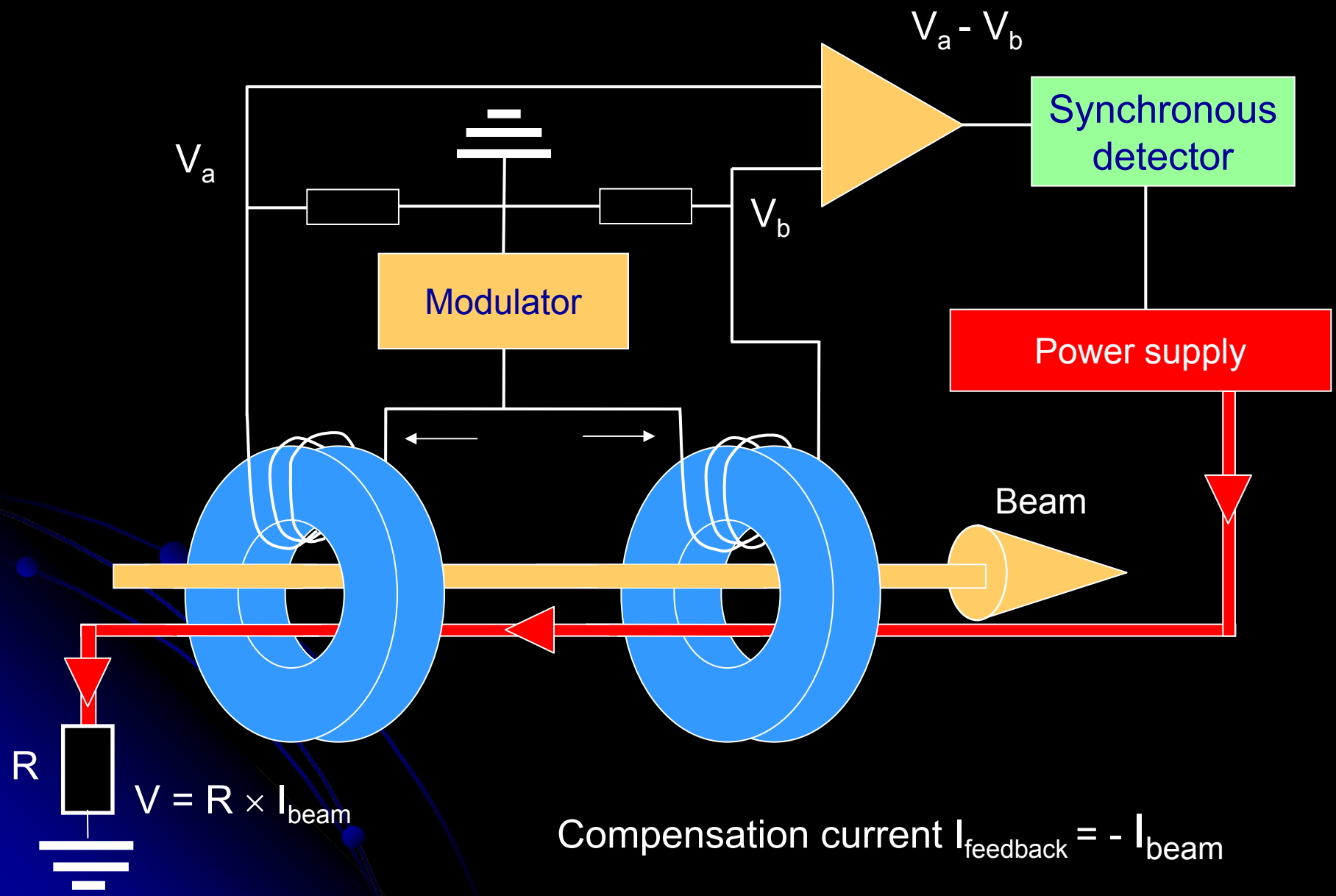


$\frac{dB}{dt}$ - Core 1 (V_1)
 $\frac{dB}{dt}$ - Core 2 (V_2)
Output voltage = $V_1 - V_2$





Zero Flux DCCT Schematic



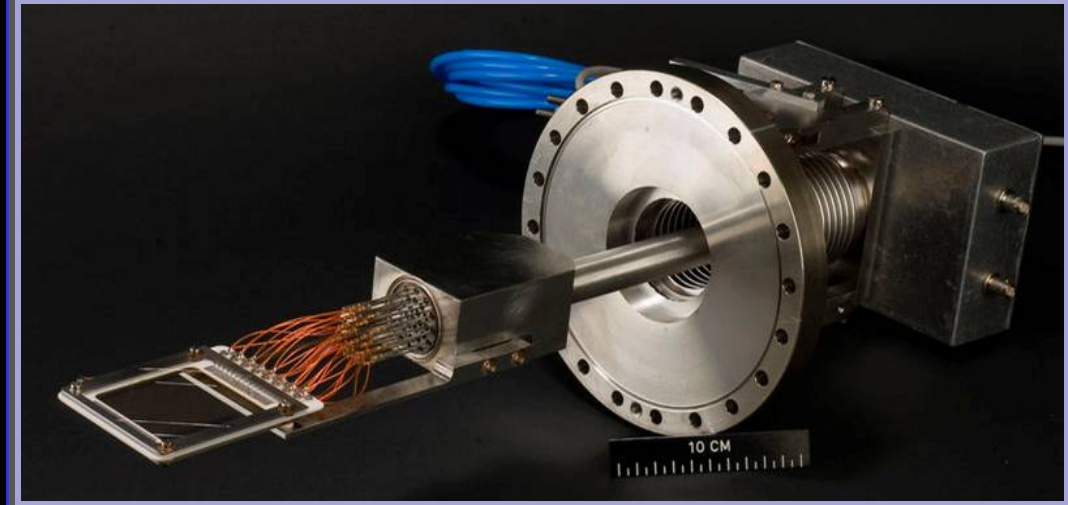
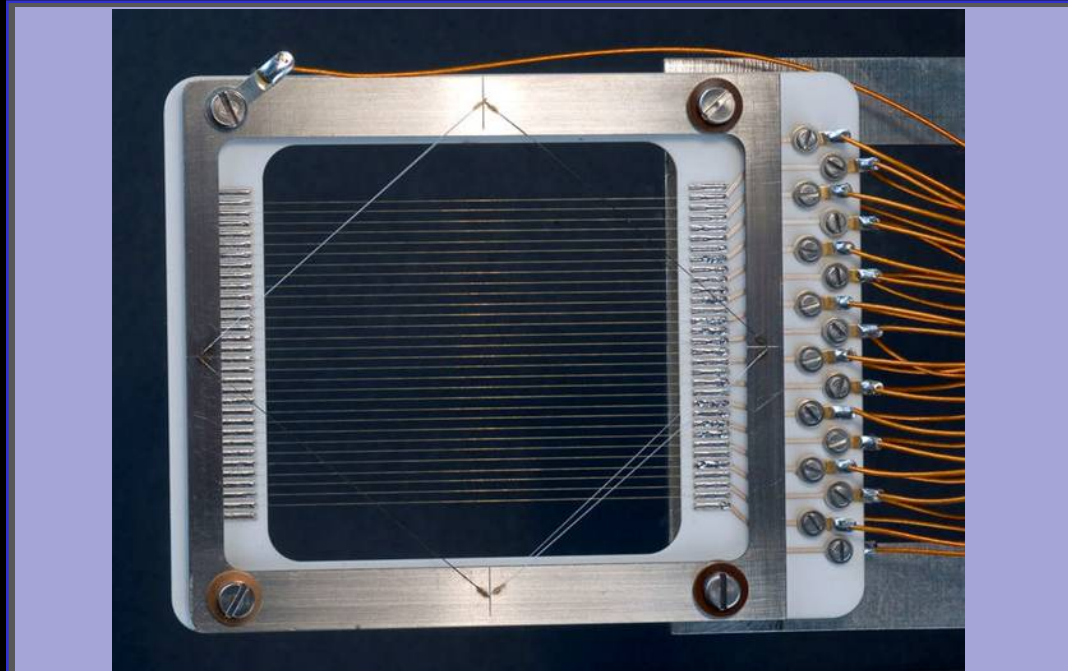


The Typical Instruments

- Beam Position
 - electrostatic or electromagnetic pick-ups and related electronics
- Beam Intensity
 - beam current transformers
- Beam Profile
 - secondary emission grids and screens
 - wire scanners
 - synchrotron light monitors
 - ionisation and luminescence monitors
 - femtosecond diagnostics for ultra short bunches (afternoon course)
- Beam Loss
 - ionisation chambers or pin diodes
- Machine Tunes and Chromacities
 - in diagnostics section of tomorrow
- Luminosity
 - in diagnostics section of tomorrow

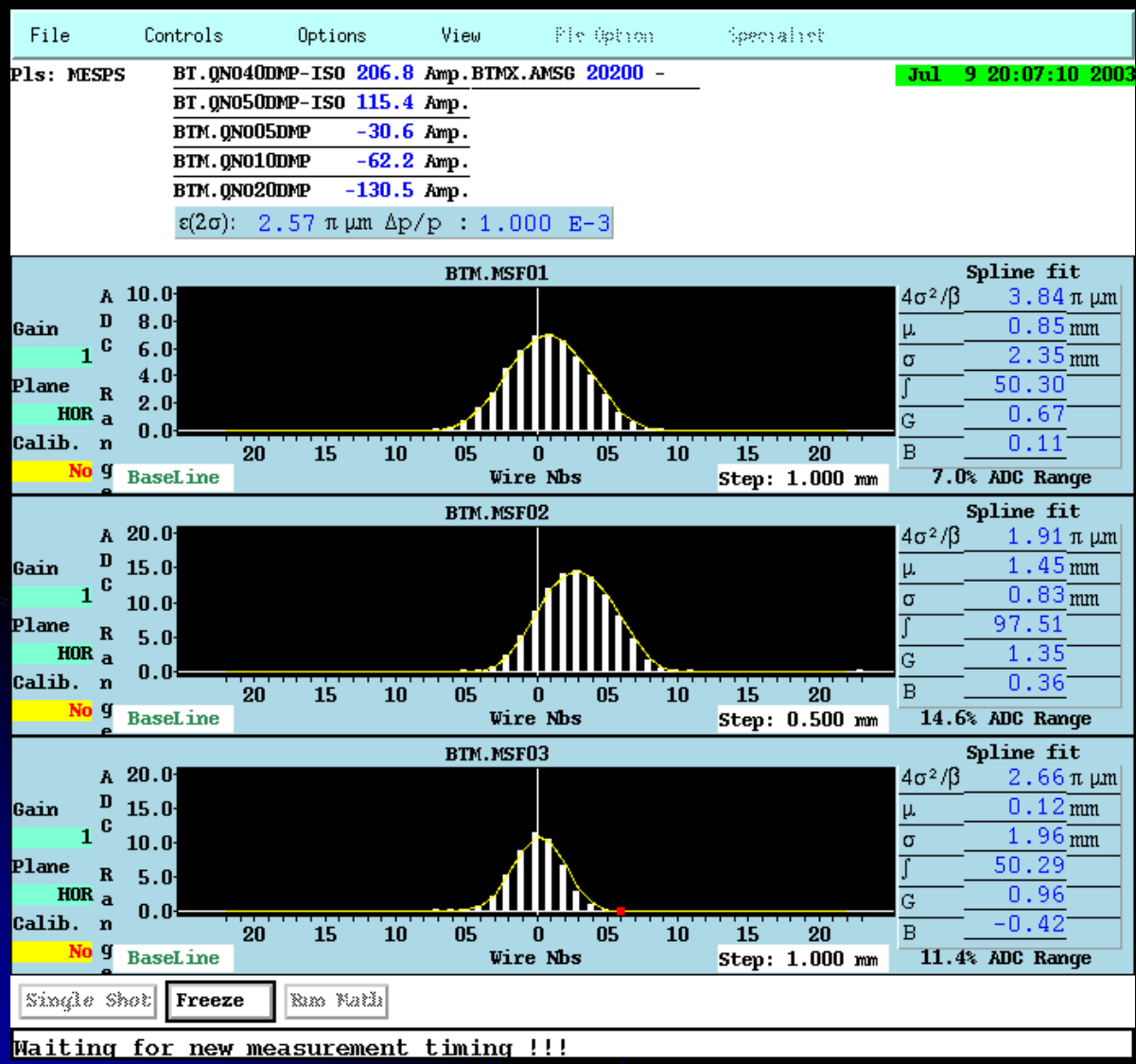
Secondary Emission (SEM) Grids

- When the beam passes through secondary electrons are ejected from the wires
- The liberated electrons are removed using a polarisation voltage
- The current flowing back onto the wires is measured
- One amplifier/ADC chain is used for each wire





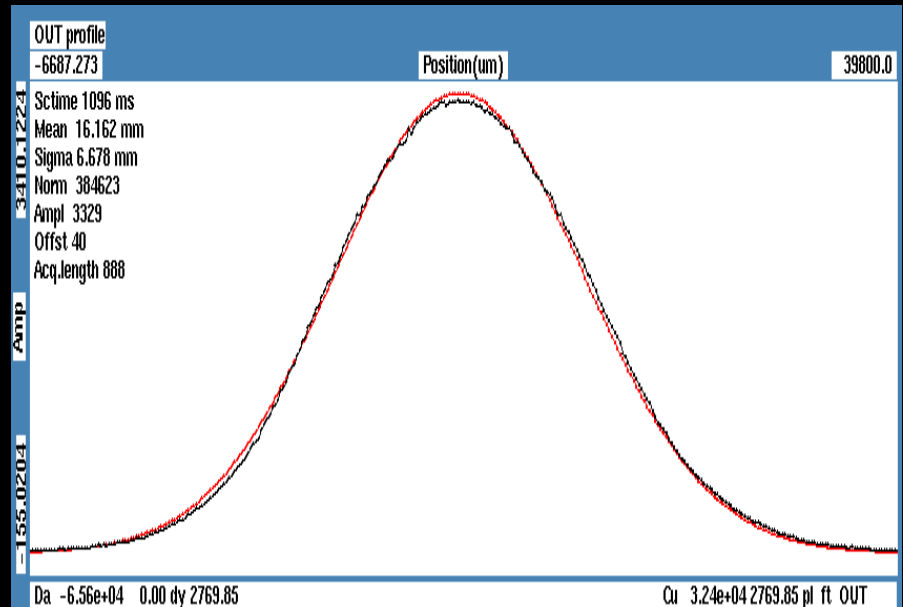
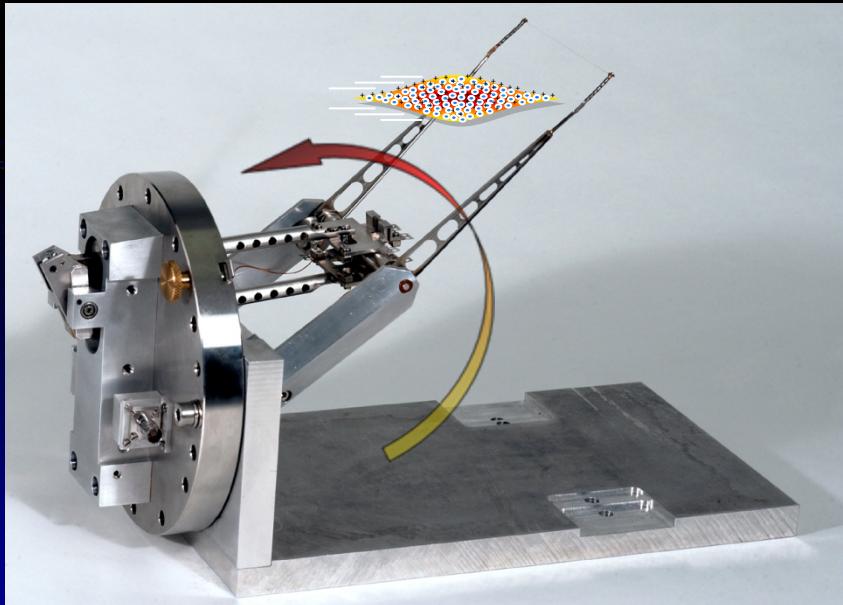
Profiles from SEM grids



- Charge density measured from each wire gives a projection of the beam profile in either horizontal or vertical plane
- Resolution is given by distance between wires
- Used only in transfer lines as heating is too great for circulating beams

Wire Scanners

- For circulating beams a thin wire is moved across the beam
 - has to move fast to avoid excessive heating of the wire
- Detection
 - Secondary particle shower detected outside the vacuum chamber using a scintillator/photo-multiplier assembly
 - Secondary emission current detected as for SEM grids
- Correlating wire position with detected signal gives the beam profile





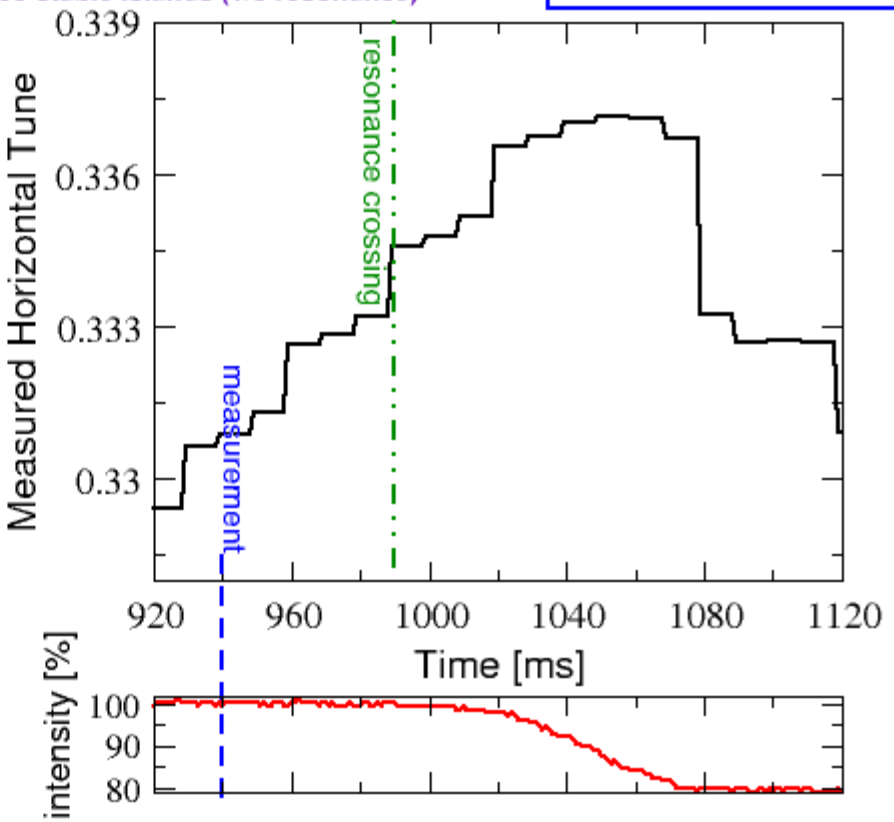
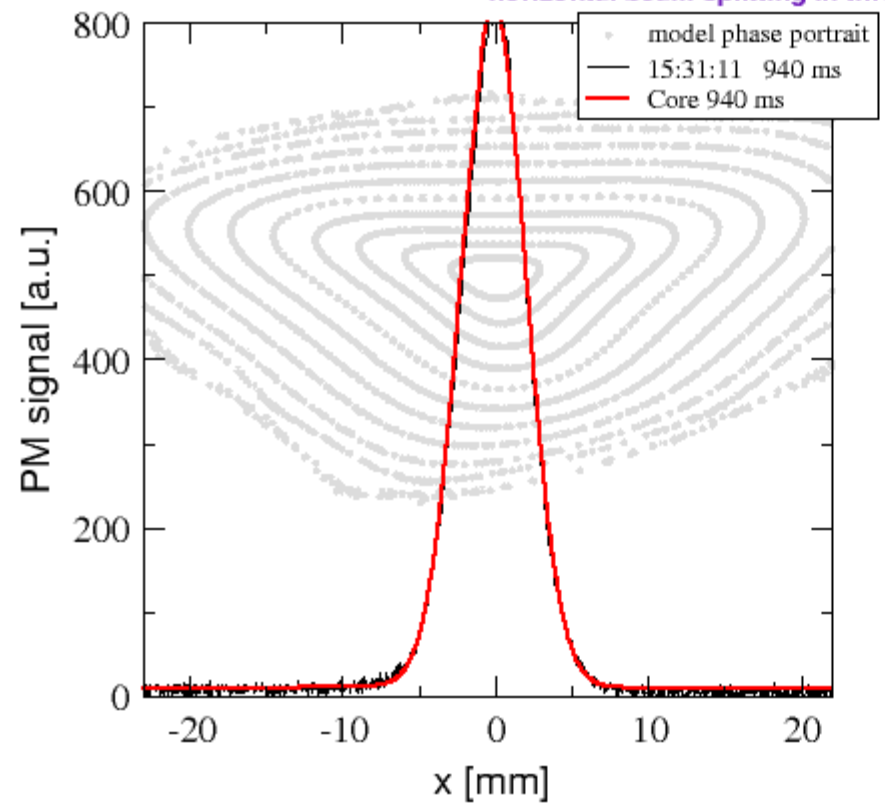
More Exotic Measurement Results

profile @ H54 FWS

PS Multi-Turn Extraction experiment, 10 August 2007

OCT=-420 A $Q_y=6.20$
XCT= 330 A

horizontal beam splitting in three stable islands (1/3 resonance)



- Wire Scanners used in the optimisation of Multi-Turn Extraction in the CERN PS
 - Clever use of Octupolar and Sextupolar fields splits the beam into 3 beamlets
 - These are separated in phase space by changing the tune and crossing the 1/3rd resonance
 - Once separated these individual beamlets can be extracted with minimal losses

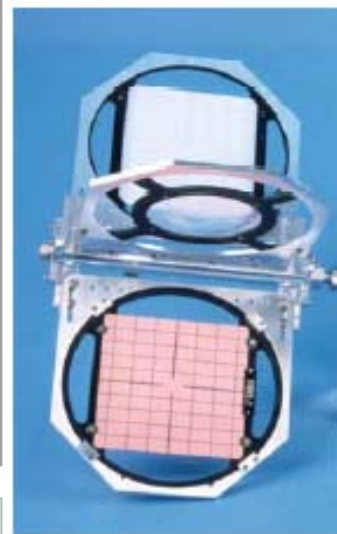


Beam Profile Monitoring using Screens

- Screen Types
 - Luminescence Screens
 - destructive (thick) but work during setting-up with low intensities
 - Optical Transition Radiation (OTR) screens
 - much less destructive (thin) but require higher intensity

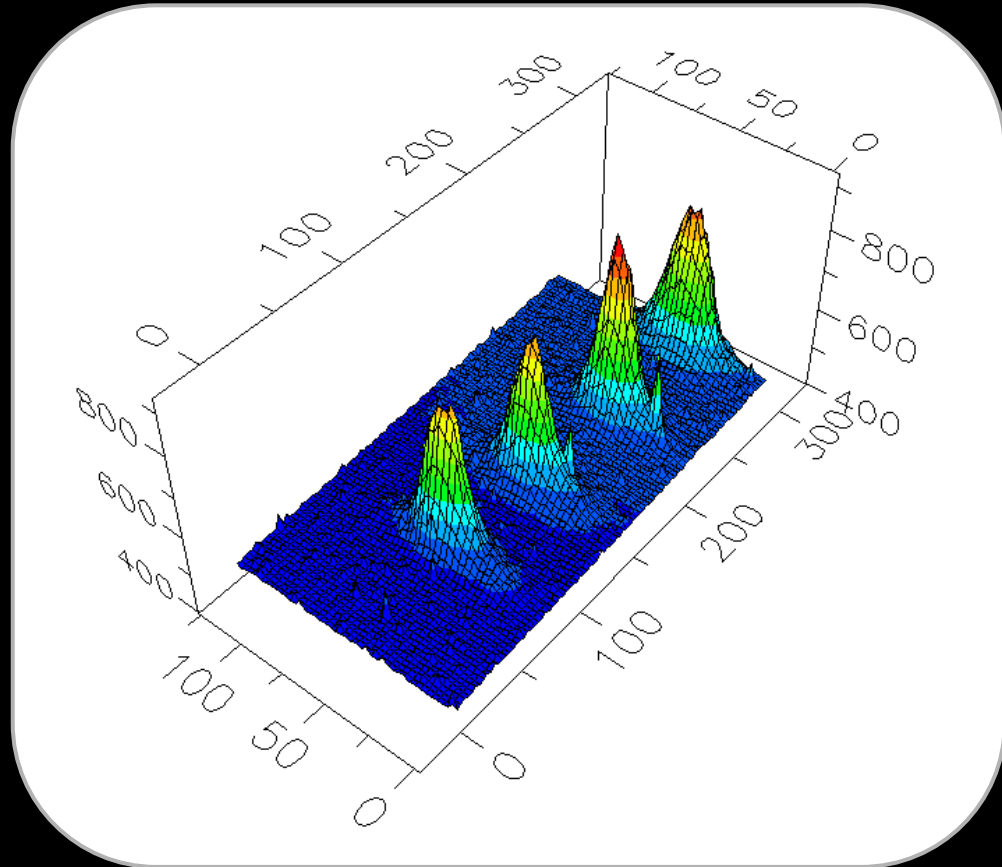
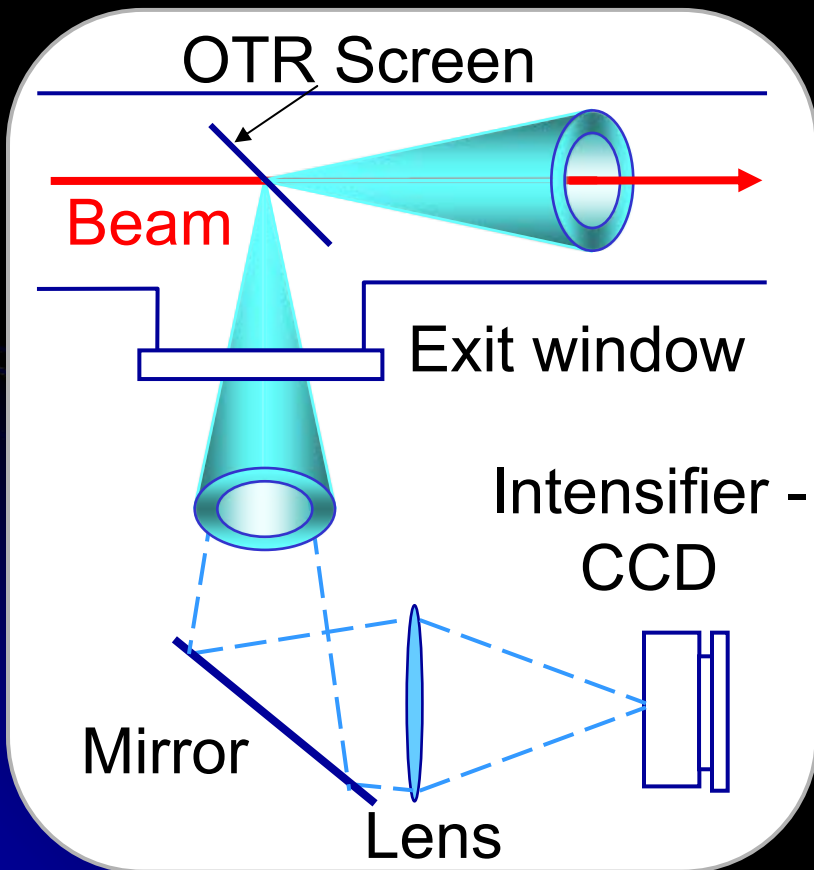
Sensitivities measured with protons with previous screen holder, normalised for $7 \text{ px}/\sigma$

Type	Material	Activator	Sensitivity
Luminesc.	CsI	Tl	$6 \cdot 10^5$
“	Al ₂ O ₃	0.5%Cr	$3 \cdot 10^7$
“	Glass	Ce	$3 \cdot 10^9$
“	Quartz	none	$6 \cdot 10^9$
OTR [bwd]	Al		$2 \cdot 10^{10}$
“	Ti		$2 \cdot 10^{11}$
“	C		$2 \cdot 10^{12}$
Luminesc. GSI	P43: Gd ₂ O ₂ S	Tb	$2 \cdot 10^7$



OTR – The Principle

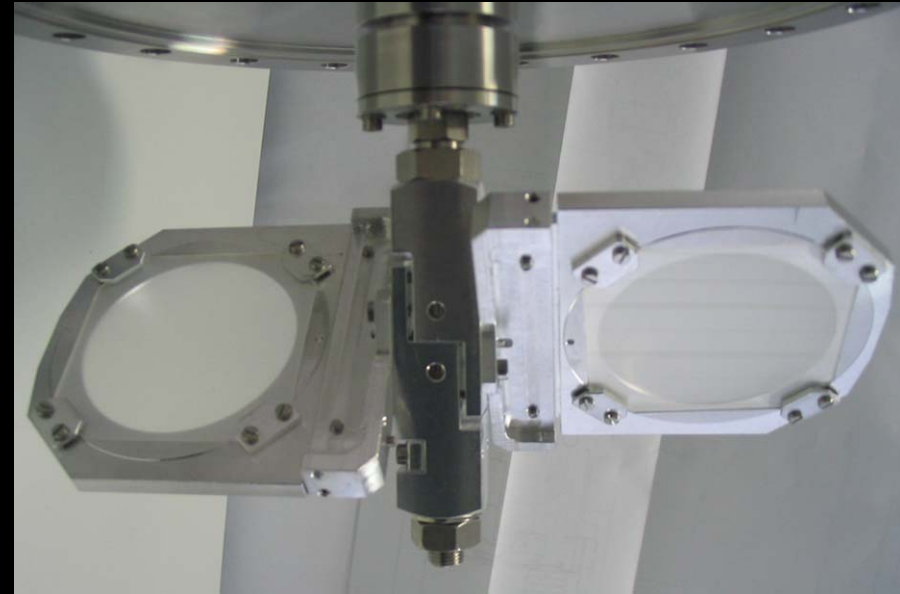
- Radiation emitted when a charged particle beam goes through the interface of 2 media with different dielectric constants
 - surface phenomenon allows the use of very thin screens ($\sim 10\mu\text{m}$)



Beam Profile Monitoring using Screens

- Usual configuration

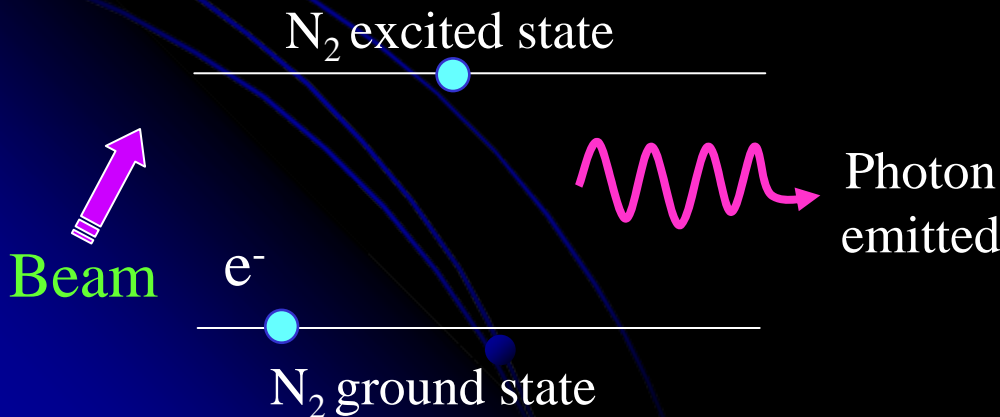
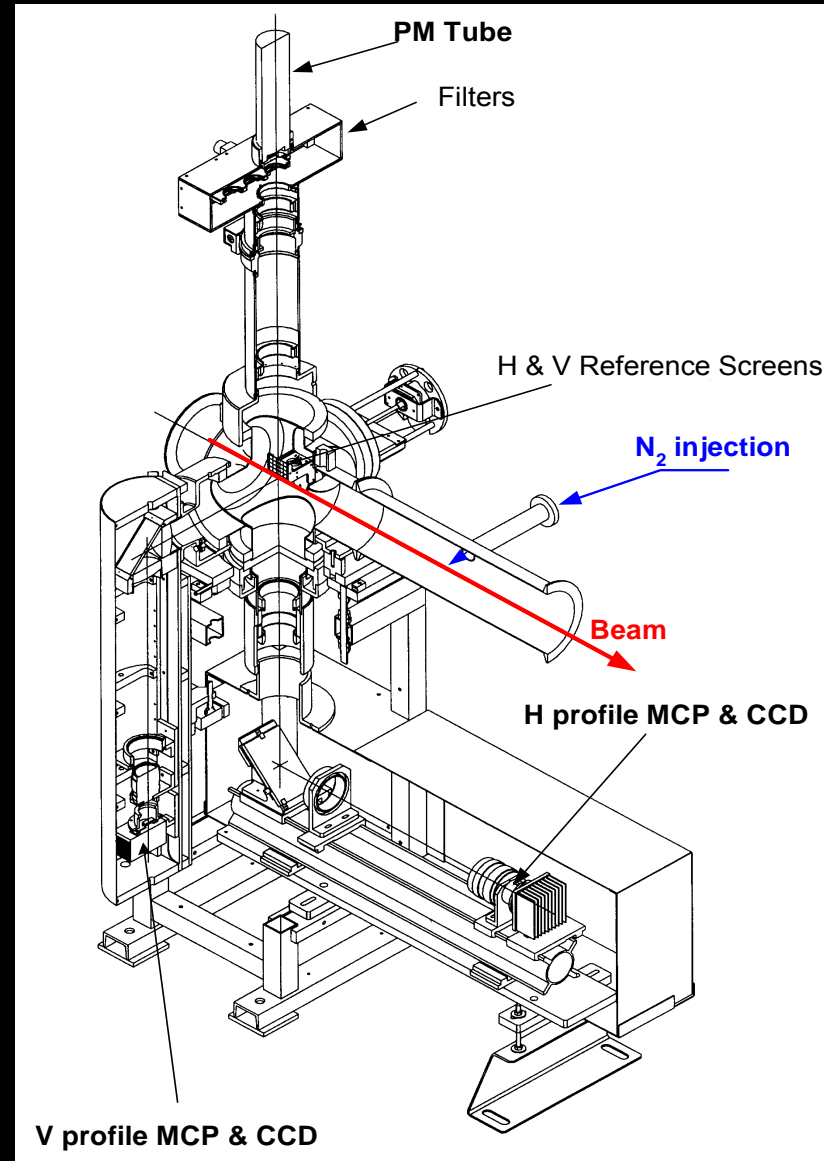
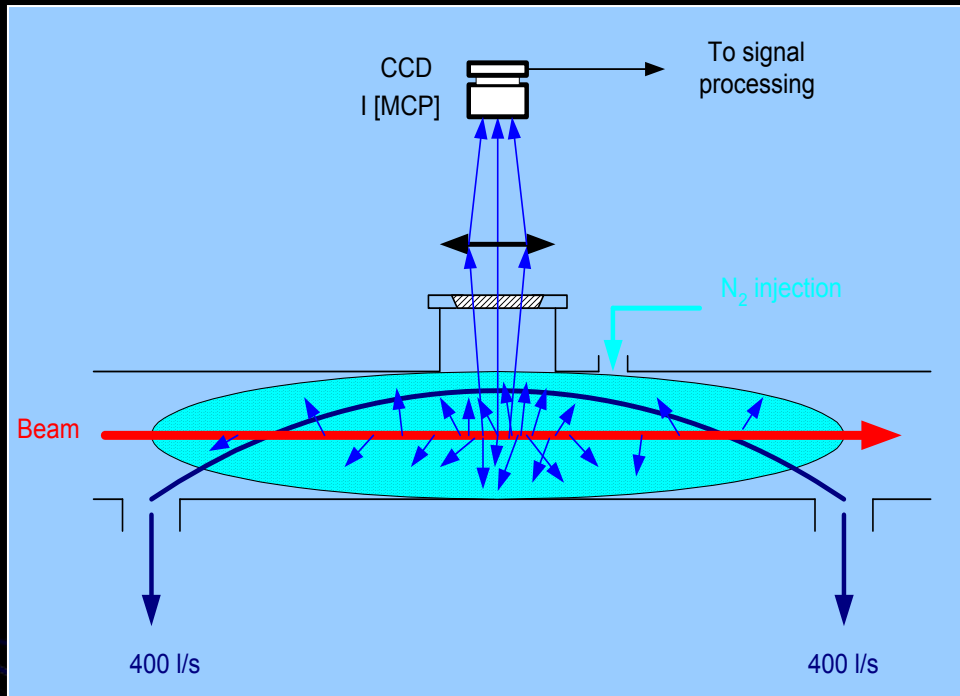
- Combine several screens in one housing e.g.
 - Al_2O_3 luminescent screen for setting-up with low intensity
 - Thin ($\sim 10\mu\text{m}$) Ti OTR screen for high intensity measurements
 - Carbon OTR screen for very high intensity operation



- Advantages compared to SEM grids

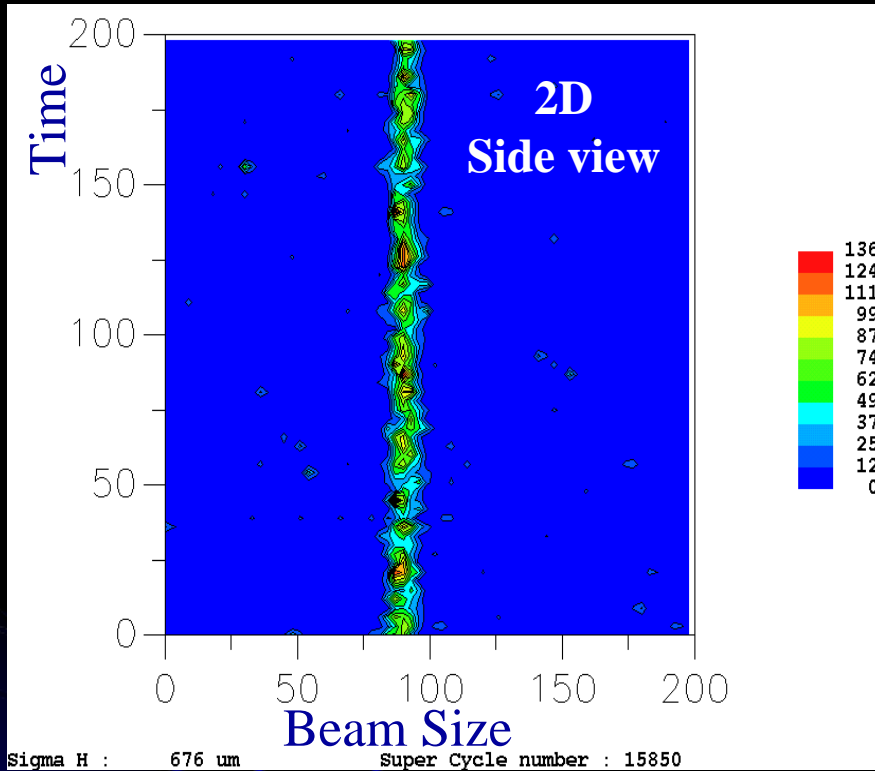
- allows analogue camera or CCD acquisition
- gives two dimensional information
- high resolution: $\sim 400 \times 300 = 120'000$ pixels for a standard CCD
- more economical
 - Simpler mechanics & readout electronics
- Time resolution depends on choice of image capture device
 - From CCD in video mode at 50Hz to Streak camera in the GHz range

Luminescence Profile Monitor





Luminescence Profile Monitor

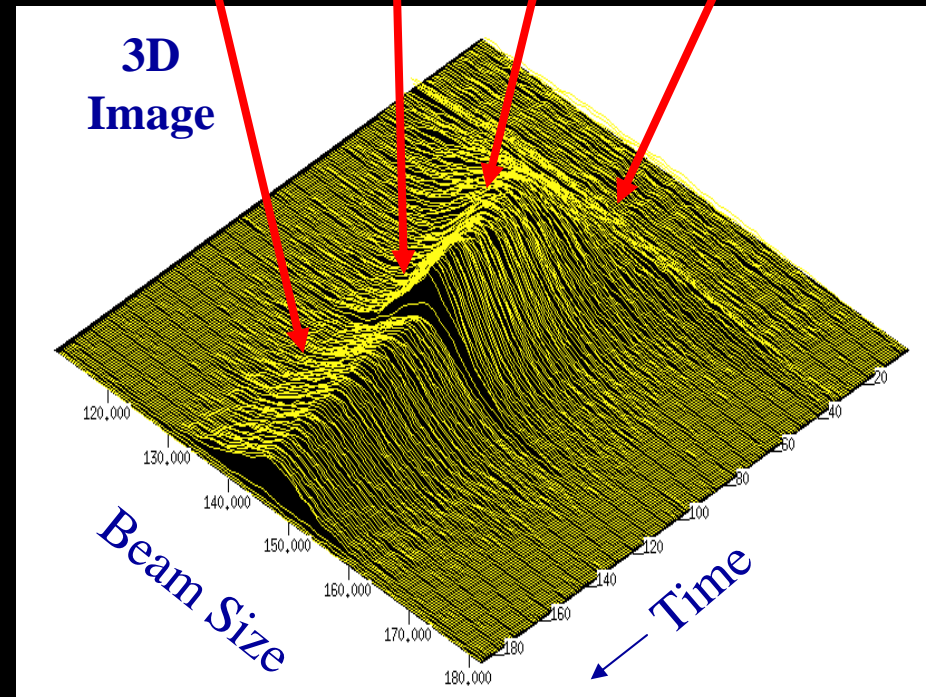


Beam size shrinks as beam is accelerated

Fast extraction

Slow extraction

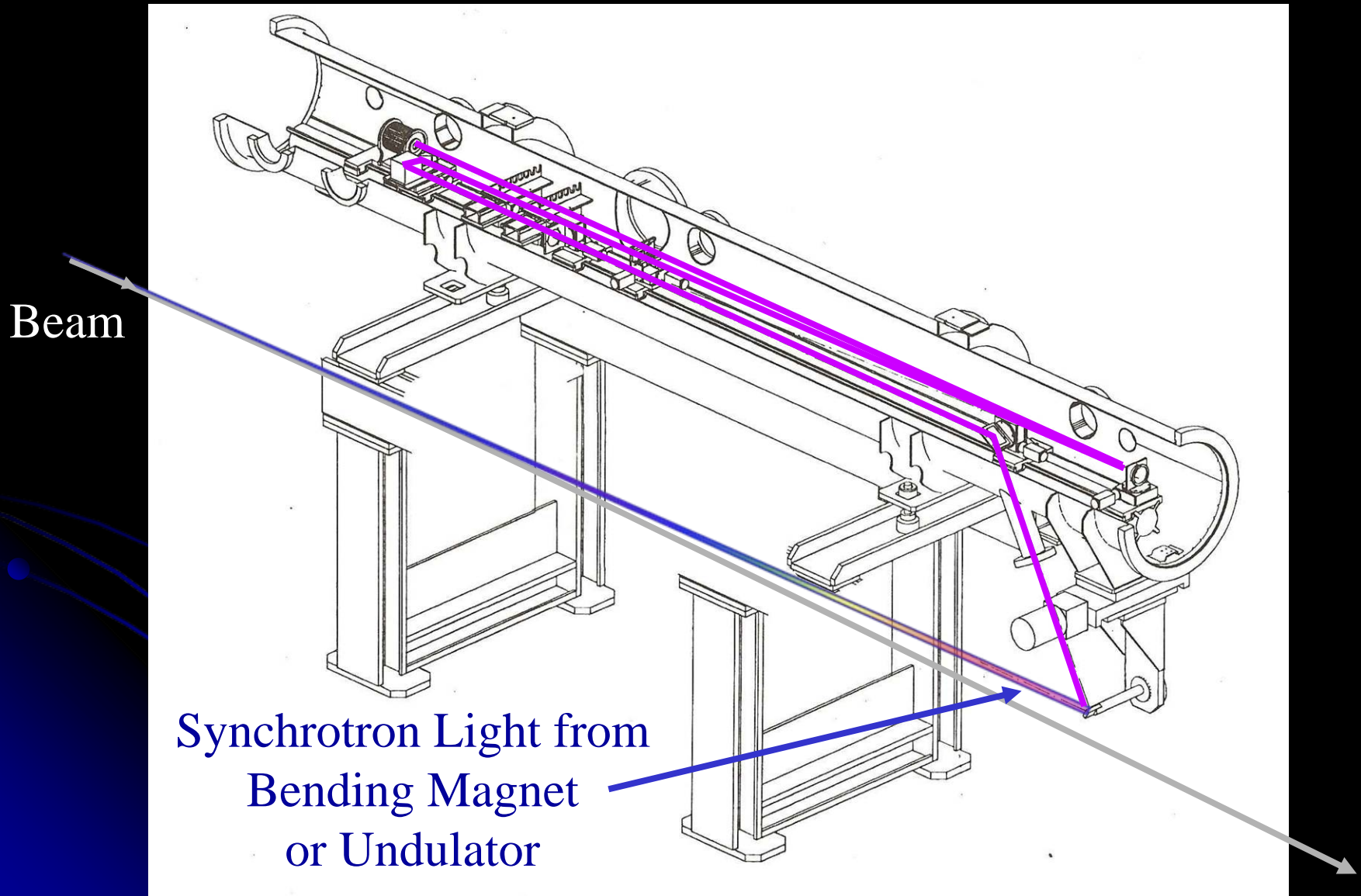
Injection



CERN-SPS Measurements

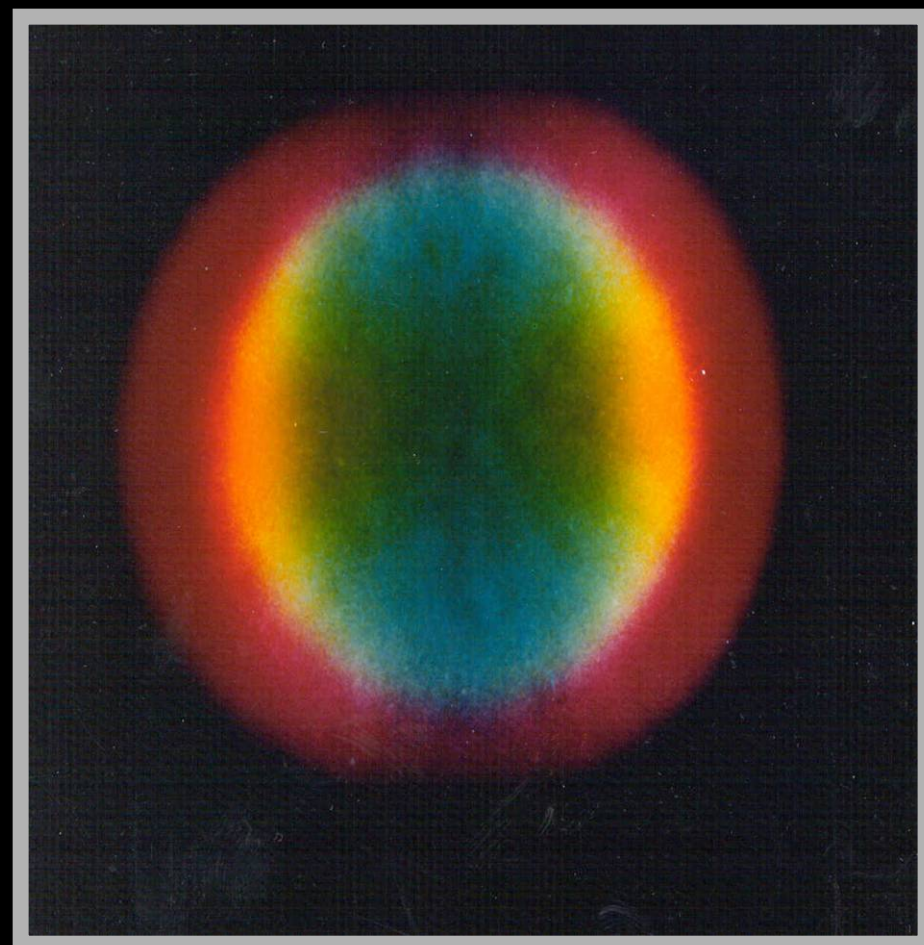
- Profile Collected every 20ms
- Local Pressure at $\sim 5 \times 10^{-7}$ Torr

The Synchrotron Light Monitor





The Synchrotron Light Monitor





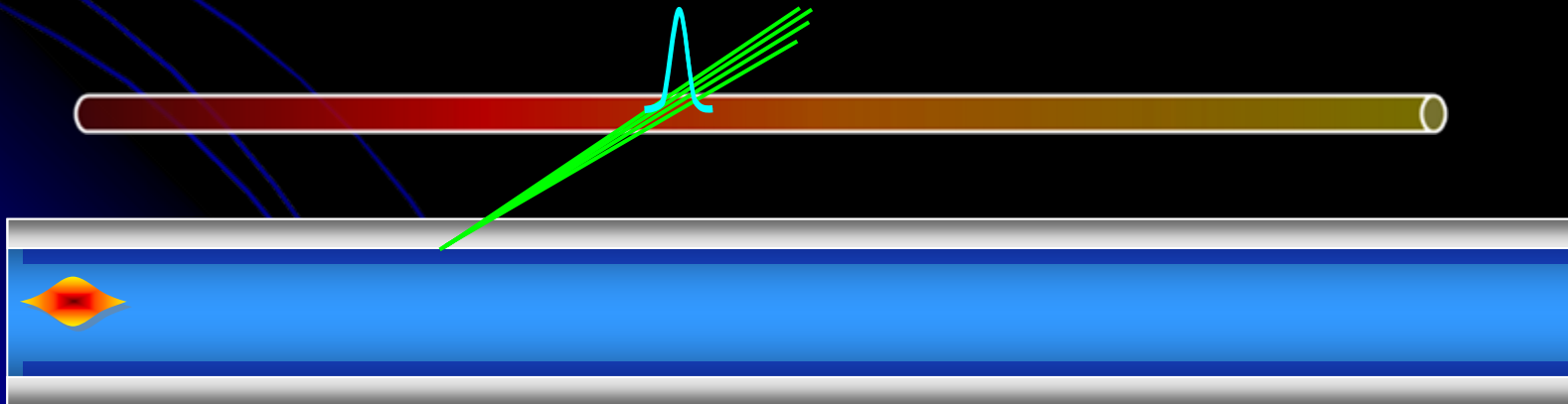
The Typical Instruments

- Beam Position
 - electrostatic or electromagnetic pick-ups and related electronics
- Beam Intensity
 - beam current transformers
- Beam Profile
 - secondary emission grids and screens
 - wire scanners
 - synchrotron light monitors
 - ionisation and luminescence monitors
 - femtosecond diagnostics for ultra short bunches (afternoon course)
- Beam Loss
 - ionisation chambers or pin diodes
- Machine Tunes and Chromacities
 - in diagnostics section of tomorrow
- Luminosity
 - in diagnostics section of tomorrow



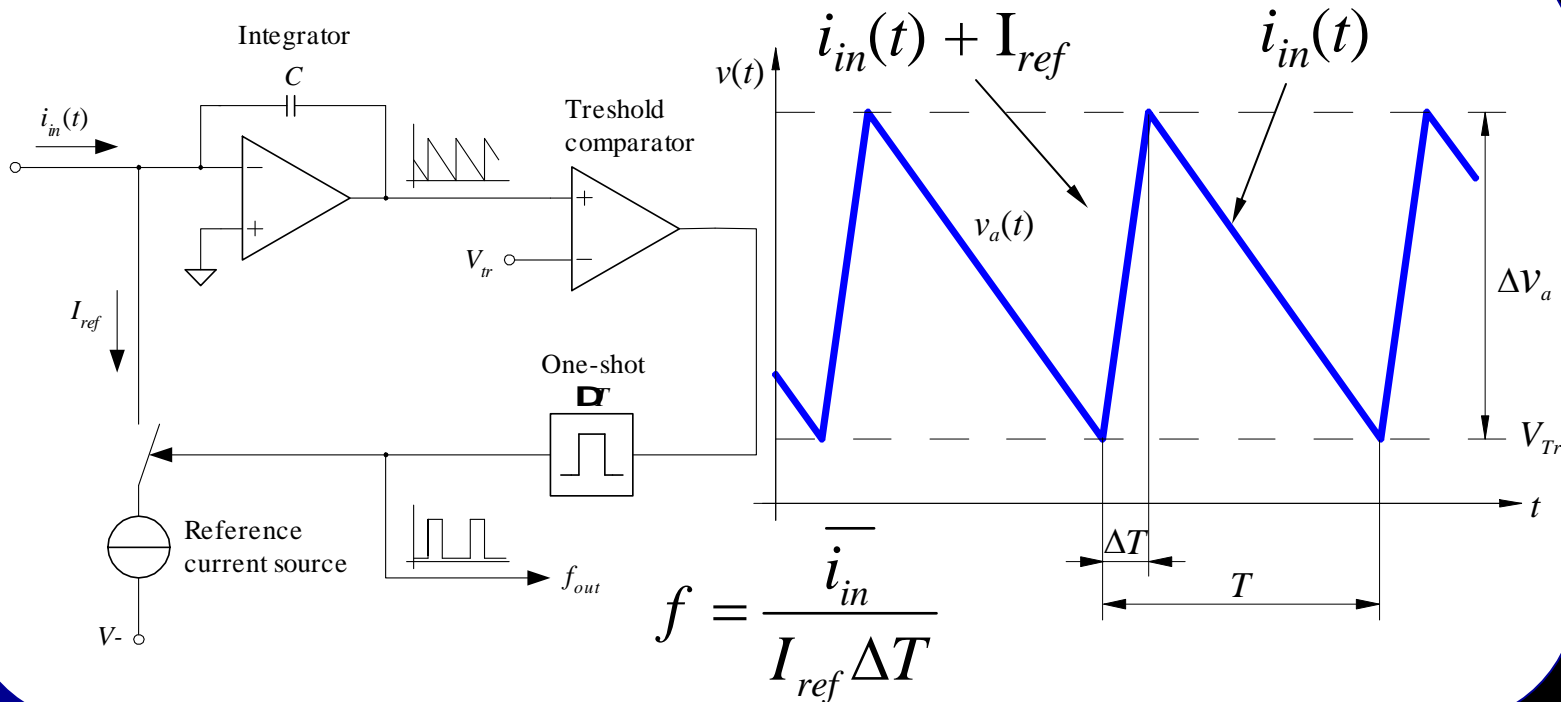
Beam Loss Detectors

- Role of a BLM system:
 1. Protect the machine from damage
 2. Dump the beam to avoid magnet quenches (for SC magnets)
 3. Diagnostic tool to improve the performance of the accelerator
- Common types of monitor
 - Long ionisation chamber (charge detection)
 - Up to several km of gas filled hollow coaxial cables
 - Position sensitivity achieved by comparing direct & reflected pulse
 - e.g. SLAC – 8m position resolution (30ns) over 3.5km cable length
 - Dynamic range of up to 10^4



Beam Loss Detectors

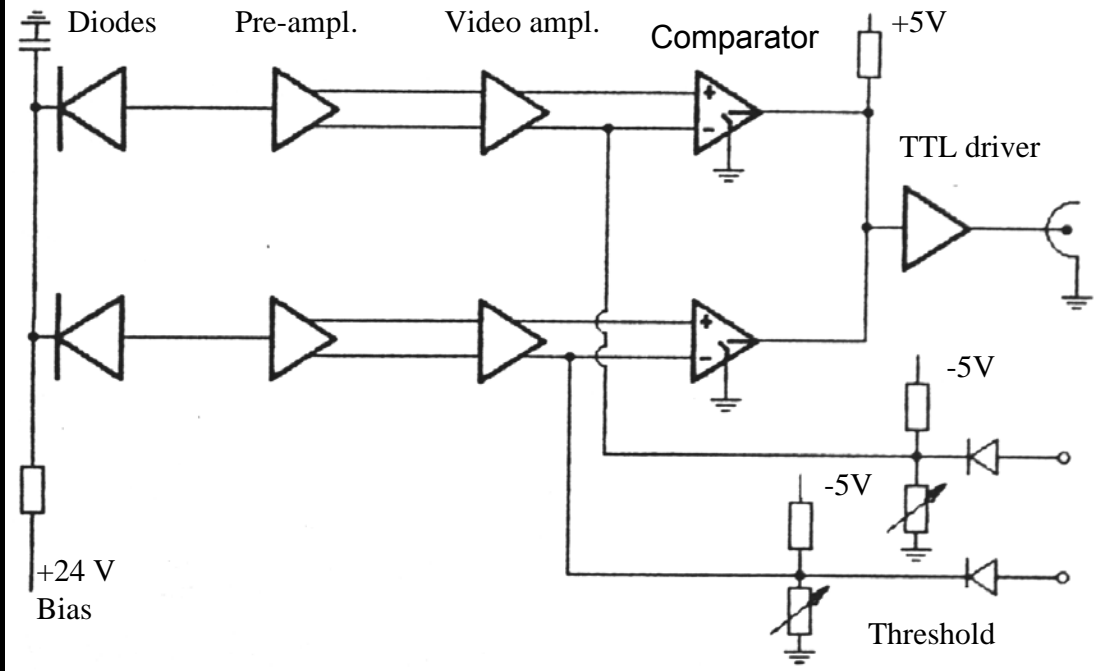
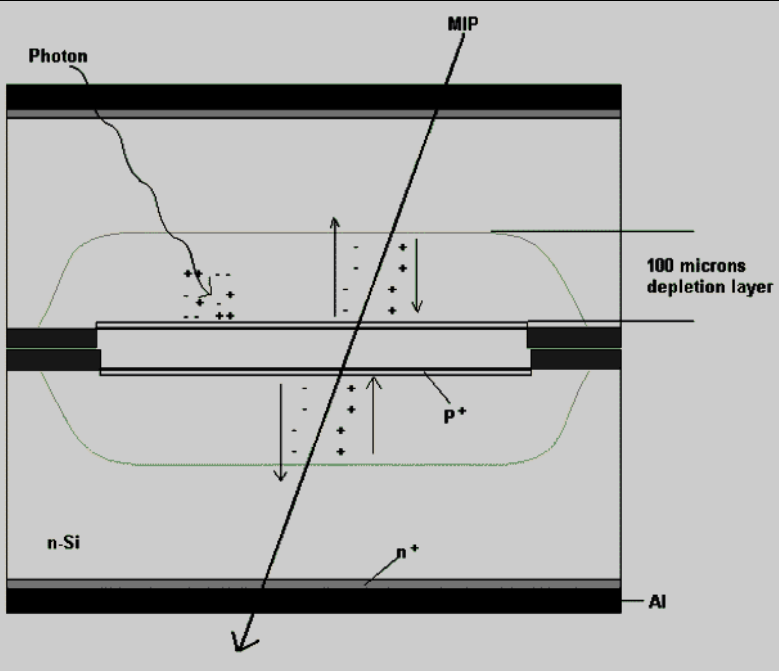
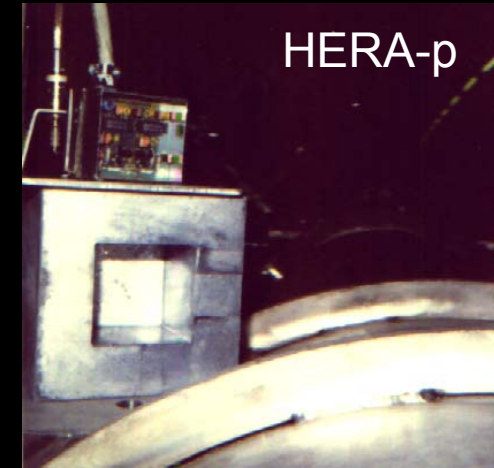
- Common types of monitor (cont)
 - Short ionisation chamber (charge detection)
 - Typically gas filled with many metallic electrodes and kV bias
 - Speed limited by ion collection time - tens of microseconds
 - Dynamic range of up to 10^8



LHC

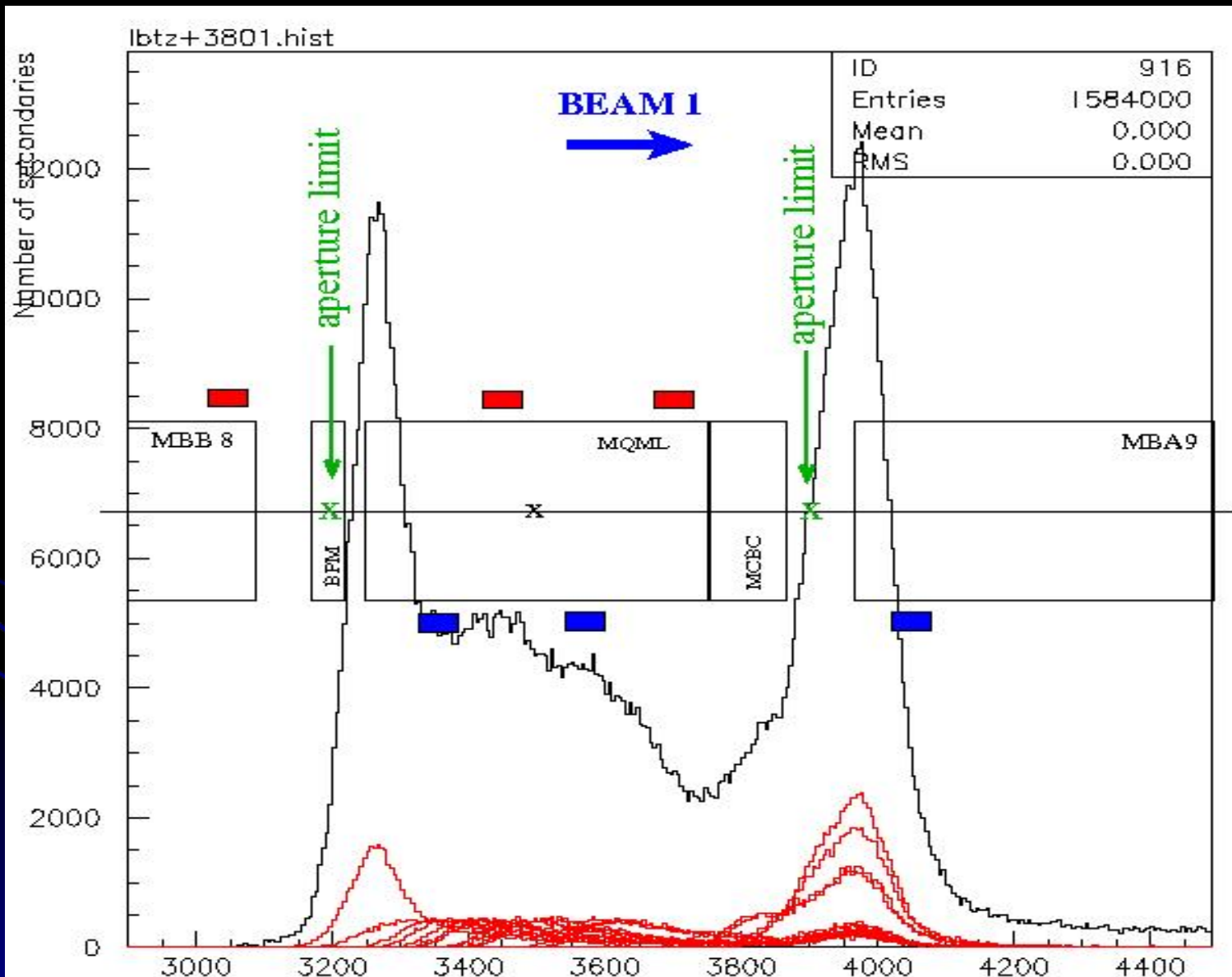
Beam Loss Detectors

- Common types of monitor (cont)
 - PIN photodiode (count detection)
 - Detect MIP crossing photodiodes
 - Count rate proportional to beam loss
 - Speed limited by integration time
 - Dynamic range of up to 10^9





BLM Threshold Level Estimation





Summary

- I've tried to give you an overview of the common types of instruments that can be found in most accelerators
 - This is only a small subset of those currently in use or being developed with many exotic instruments tailored for specific accelerator needs
- Tomorrow you will see how to use these instruments to run and optimise accelerators
 - Introduction to Accelerator Beam Diagnostics (H. Schmickler)
- Afternoon course : Beam Instrumentation & Diagnostics
 - For an in-depth analysis of all these instruments and on their application in various accelerators